

Advances in HTS Modeling

**WAMHTS-5, Budapest, April 11th
2019**

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Acknowledgement: L. Cavallucci, F. Grilli, P. L. Ribani



Outline

- **Introduction**
- **HTS tape modeling**
- **From tapes to cables**
 - **Twisted Stacked Tape Cable**
 - **Roebel cables**
- **Scaling up: coils and magnet systems**
- **Discussion**



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Main issues and problem scales...

Issues

- High aspect ratio
- Anisotropy
- Strong non-linearity
- Inhomogeneity of critical current
- Interface properties
- Problem dimensions (3D)
- Multiphysics

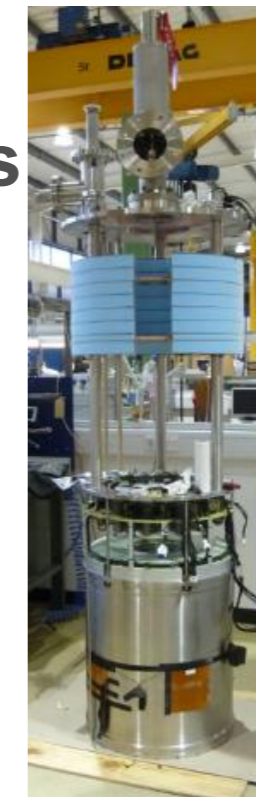
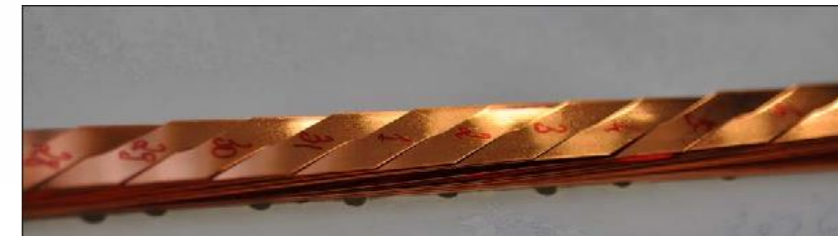
Scale

- Layer/filament
- Tape
- Cable
- Coil
- Magnet systems

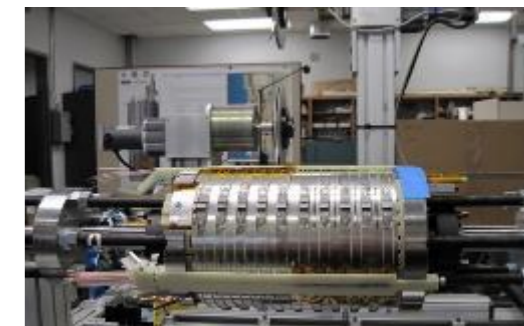
REBCO tape



Roebel Cable



Hybrid 32 T NHMFL magnet





...and modeling solutions

Modeling techniques

- **Field models (FEM, FEM-BEM, variational methods..)**
 - Homogenization
 - Multi-scale
 - Change of coordinates
 - Reduced dimensionality
 - Statistical approach (for l_c longitudinal variations)
- **Circuit models**
 - Lumped parameters
 - Distributed parameters
- **Hybrid models (field model + circuit model)**



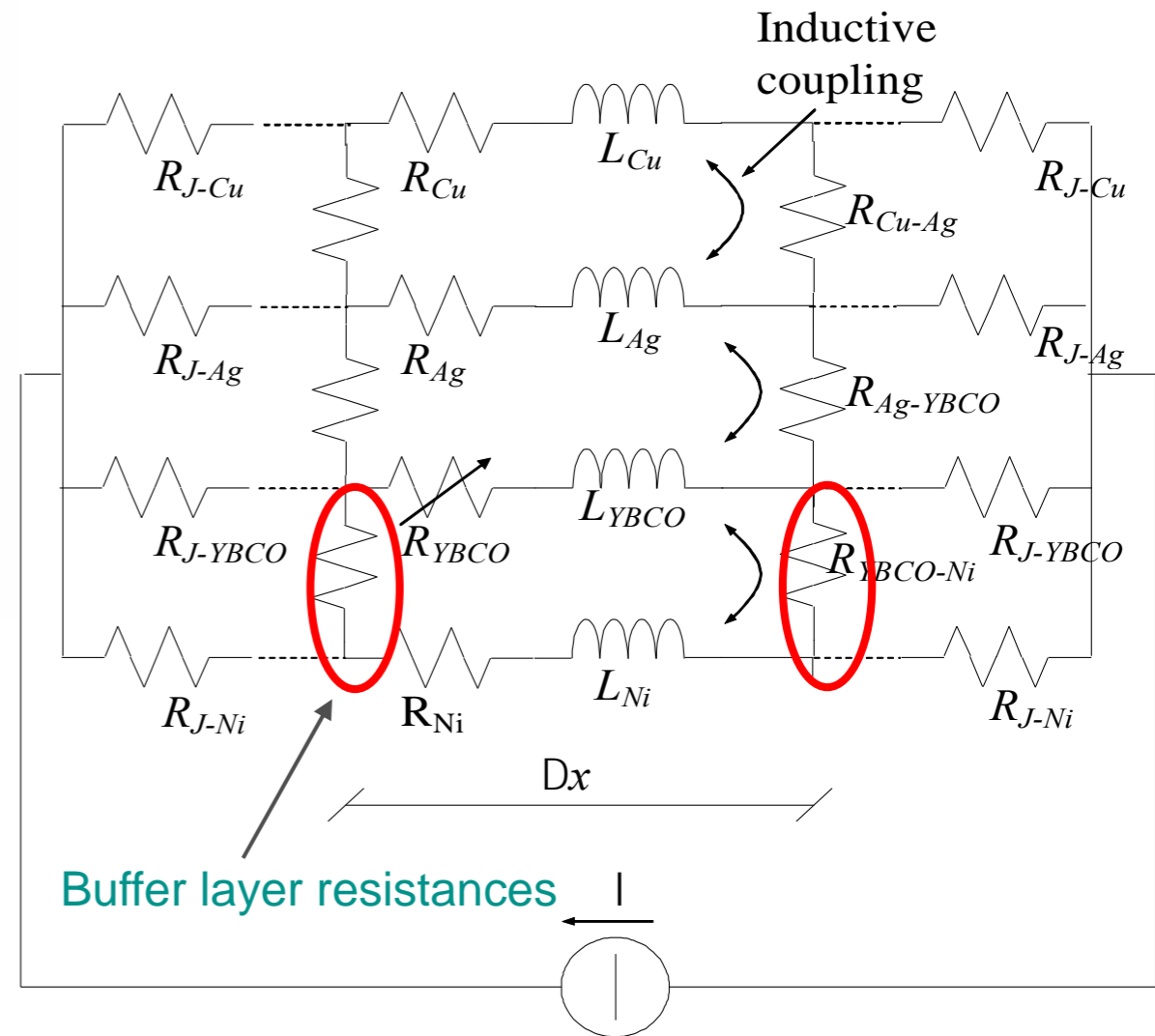
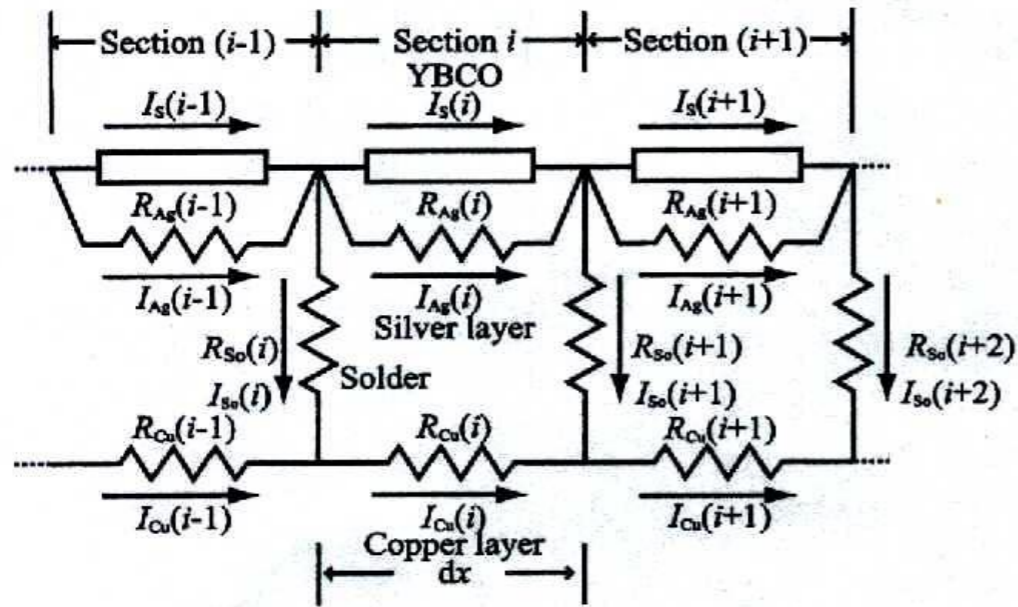
Outline

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- **HTS tape modeling**
- From tapes to cables
 - CORC
 - Twisted Stacked Tape Cable
 - Roebel cables
- Scaling up: coil and magnet systems
 - Insulated coils
 - Non insulated coils
- Discussion



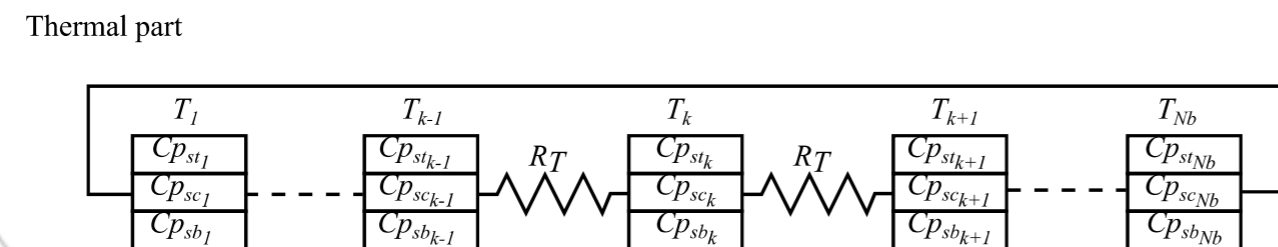
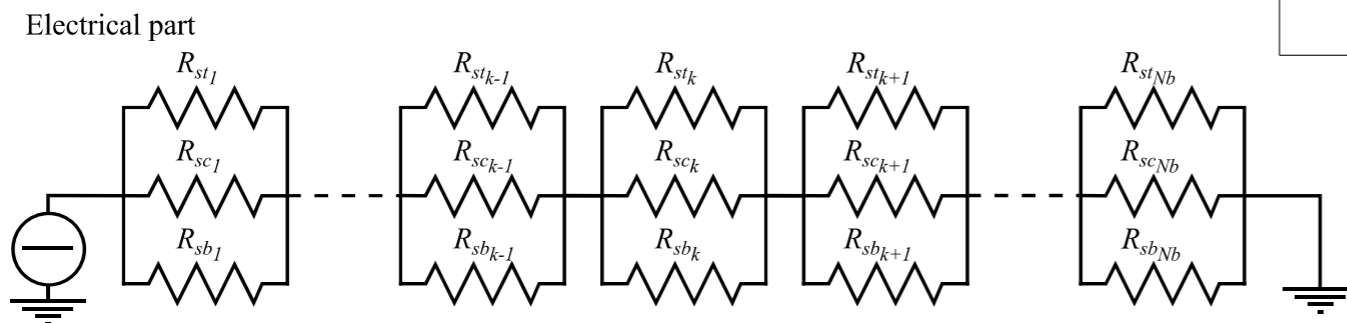
HTS tape modeling: circuit models

Lumped or distributed parameter circuit models



[1] Y. Fu, O. Tsukamoto, M. Furuse, *IEEE Trans. Appl. Supercond.*, Vol. 13, pp. 1780 – 1783, 2003.

[2] M. Breschi, P. L. Ribani, X. Wang, J. Schwartz, *Supercond. Sci. Technol.*, Vol. 20, L9 – L11, 2007.

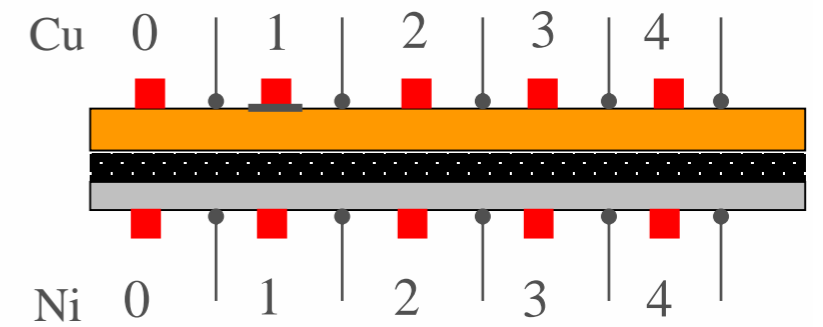
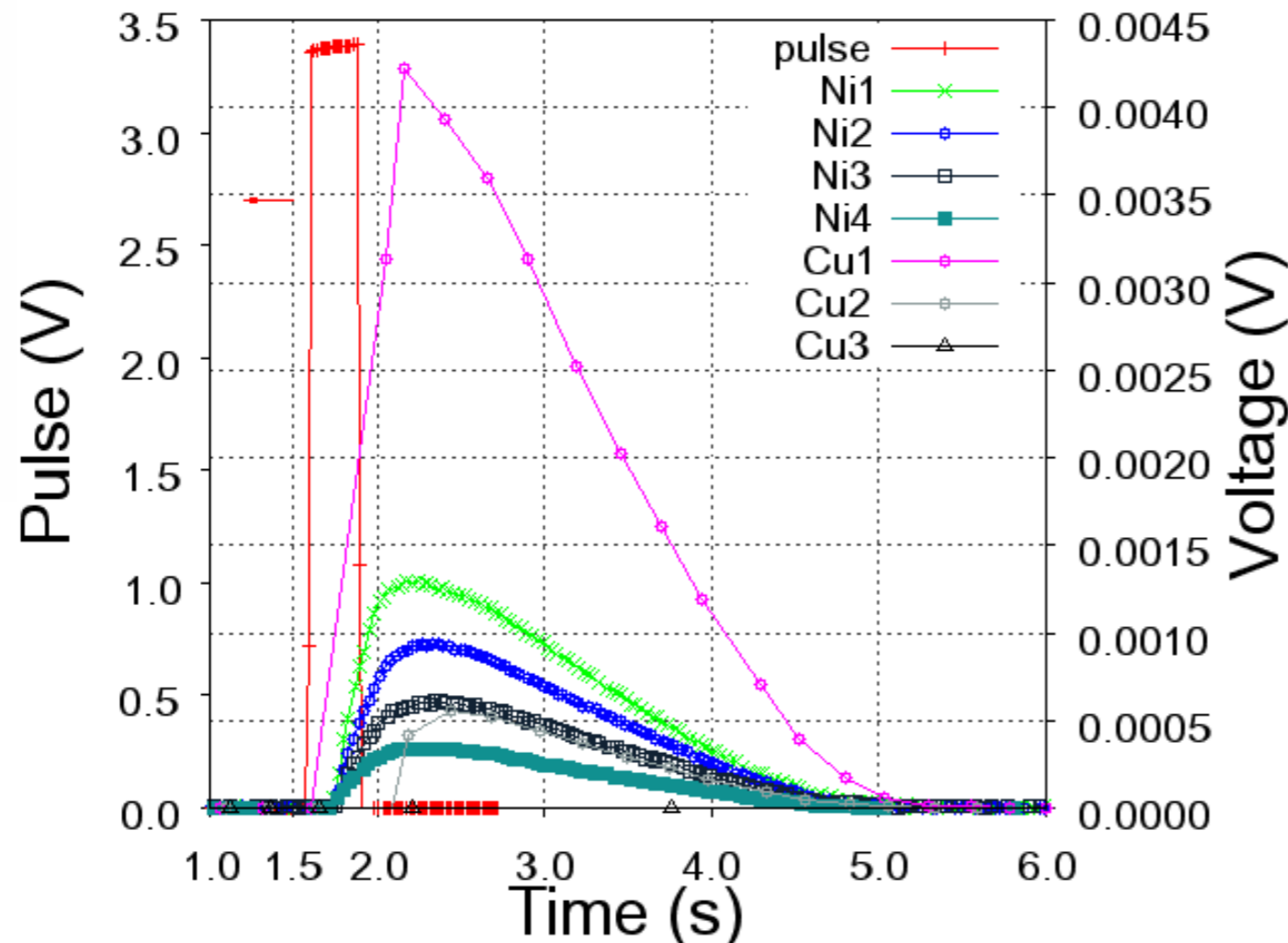


[3] D. Colangelo, B. Dutoit, *Supercond. Sci. Technol.*, Vol. 27, 124005, 2014



HTS tape modeling: circuit models

Lumped or distributed parameters circuit models



Resistive heater pulses applied on the copper side of the tape

[2] X. Wang, A. Caruso, M. Breschi, G. Zhang, U. Trociewitz, H. Weijers, J. Schwartz, *IEEE Trans. Appl. Supercond.*, Vol. 15, n. 2, pp. 2586 – 2589, 2005.

- Measured at 77 K, $I_t = 58$ A (40% I_c), pulse height = 3.42 V
- Nickel substrate and copper not equipotential
- Different voltages measured on the two sides of the tape

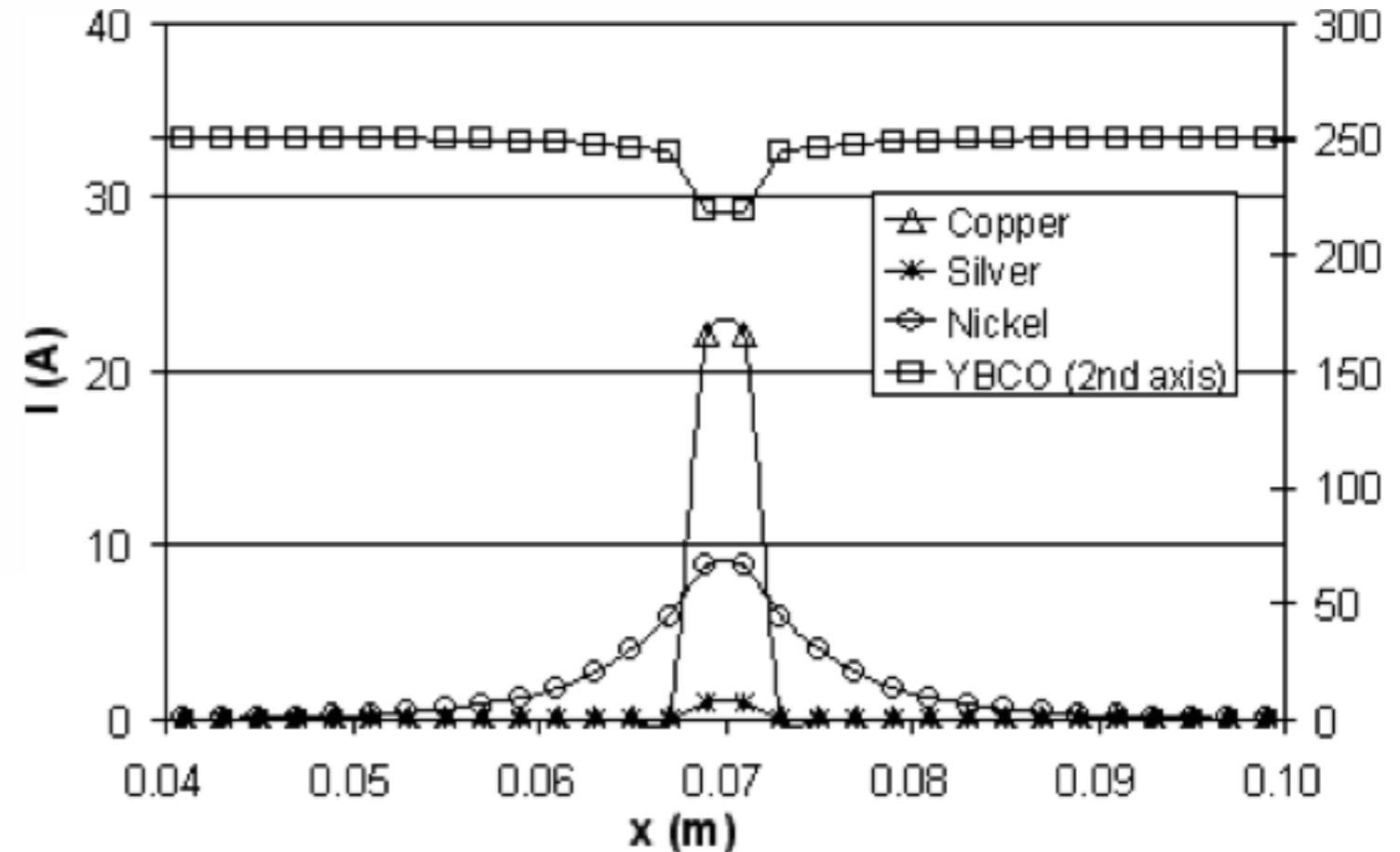


HTS tape modeling: circuit models

Current redistribution during quench

- The resistance of the buffer layer is **greater** than the transverse resistances between YBCO and Ag layers
- Current redistribution length (4 cm – 10 cm) towards the substrate greater than towards the Ag and Cu layers (1 cm - 2 cm)

$$\lambda_T = \frac{1}{\sqrt{rG}}$$



- Tuning the contact resistances can affect the quench propagation velocity

[2] M. Breschi, P. L. Ribani, X. Wang, J. Schwartz, *Supercond. Sci. Technol.* 20 L9 – L11, 2007.

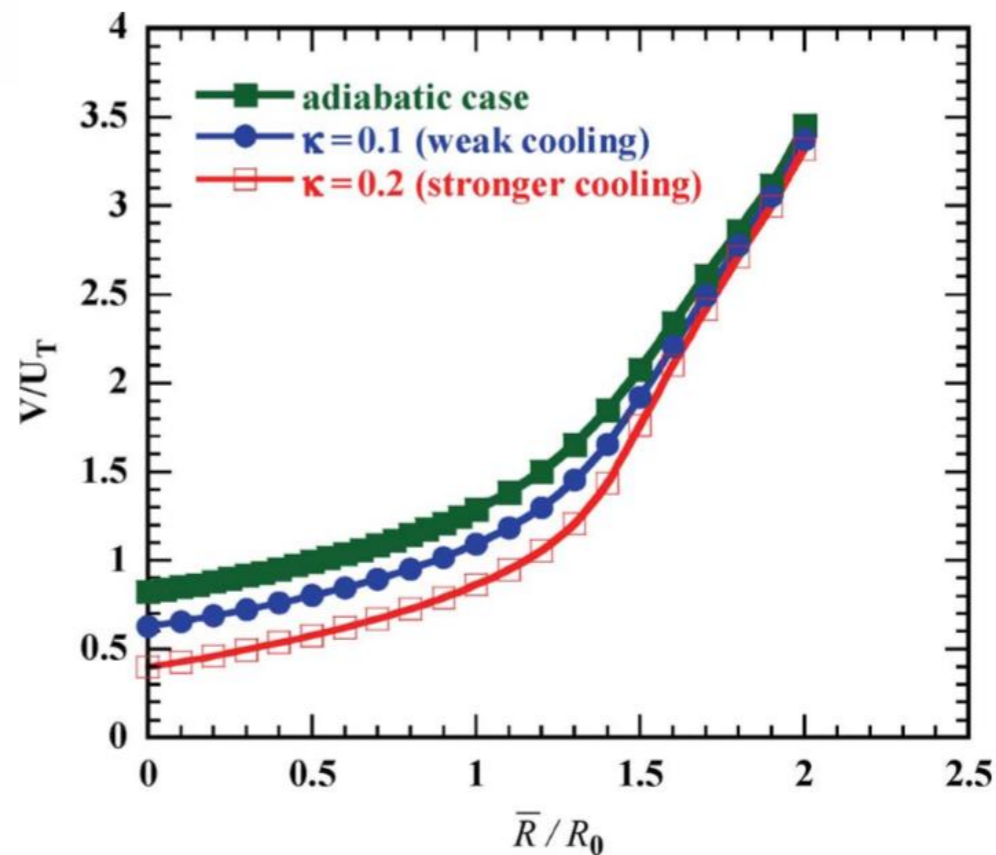


HTS tape modeling: different architectures

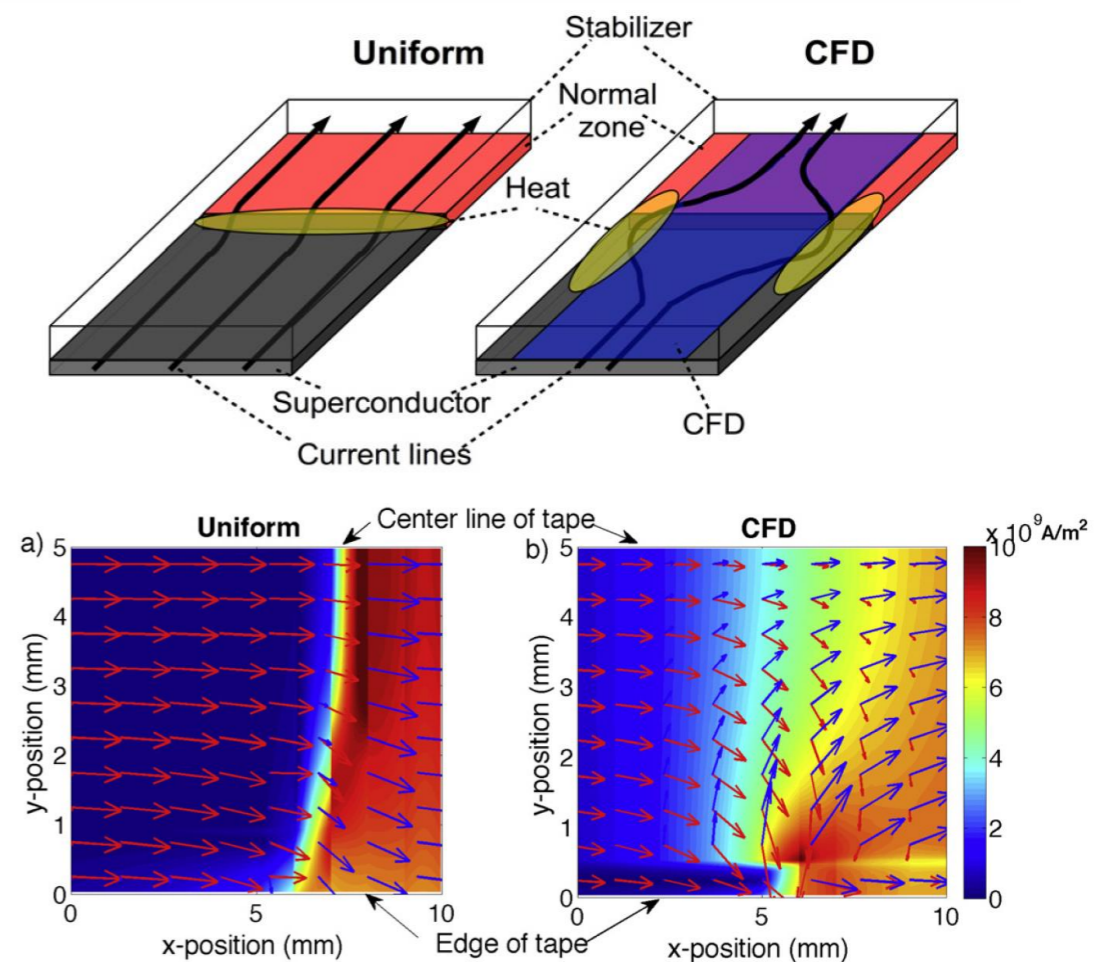
New tape architectures with higher NZPV

- Understanding the crucial role of transverse resistances in the quench development led to alternative **tape architectures**

Increasing NZPV with increasing interfacial resistance



Current flow diverter



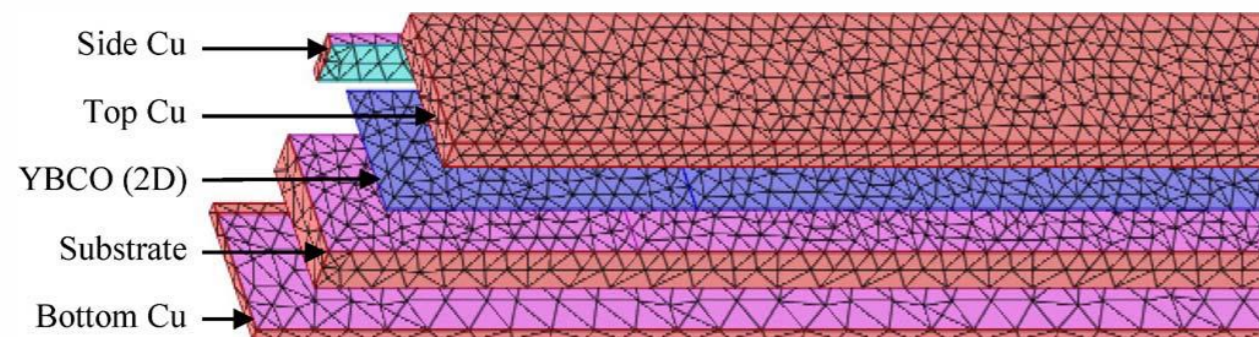
[4] Levin GA, Barnes PN, Rodriguez JP, Connors JA, Bulmer JS., *IEEE Trans. Appl. Supercond.*, Vol. 19, 2009

[5] C. Lacroix, F. Sirois, *Supercond. Sci. Technol.*, 035003, 2014.



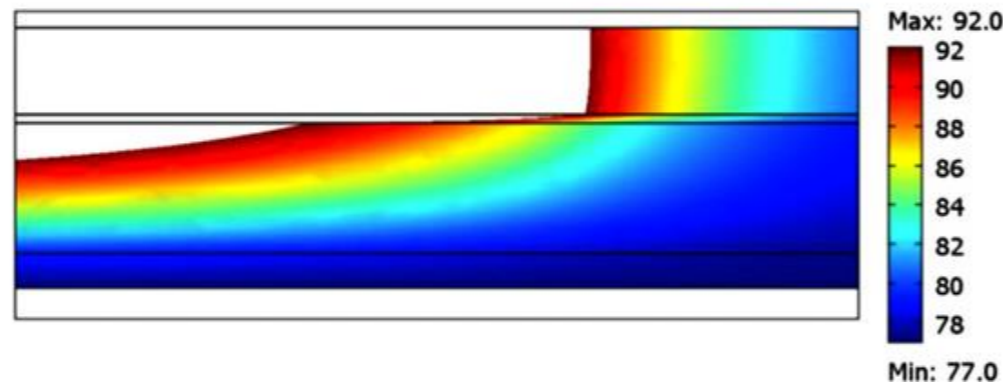
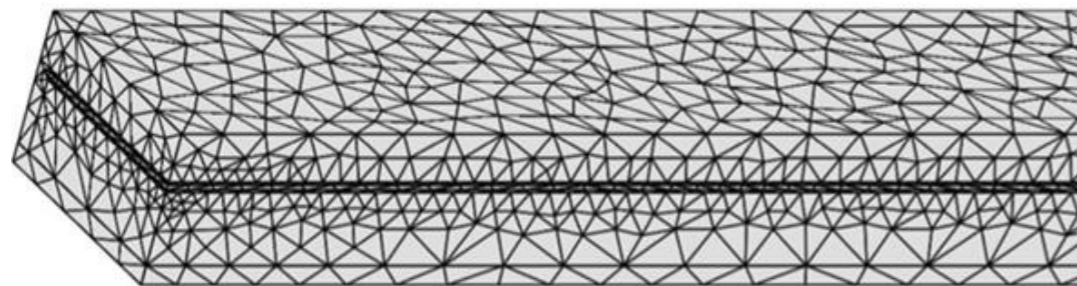
HTS tape modeling: field models

3D model and mixed dimensional method (2D – 3D)

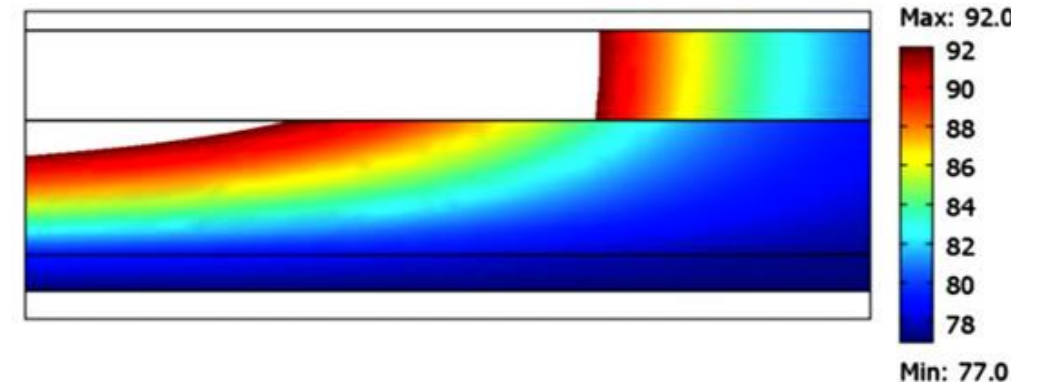
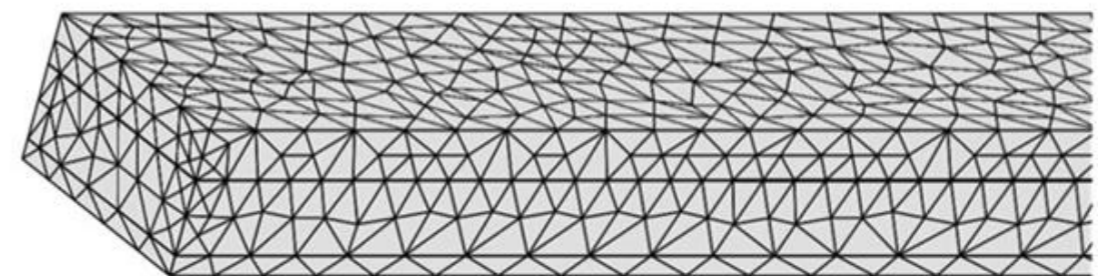


- Copper stabilizers and substrate meshed in 3-D, YBCO layer meshed as a 2-D shell.

Full 3D model



3-D/2-D model



[6] W. K. Chan, P. J. Masson, C. Luongo., *IEEE Trans. Appl. Supercond.*, Vol. 20, pp. 2370 - 2380, 2010



HTS tape modeling: field models

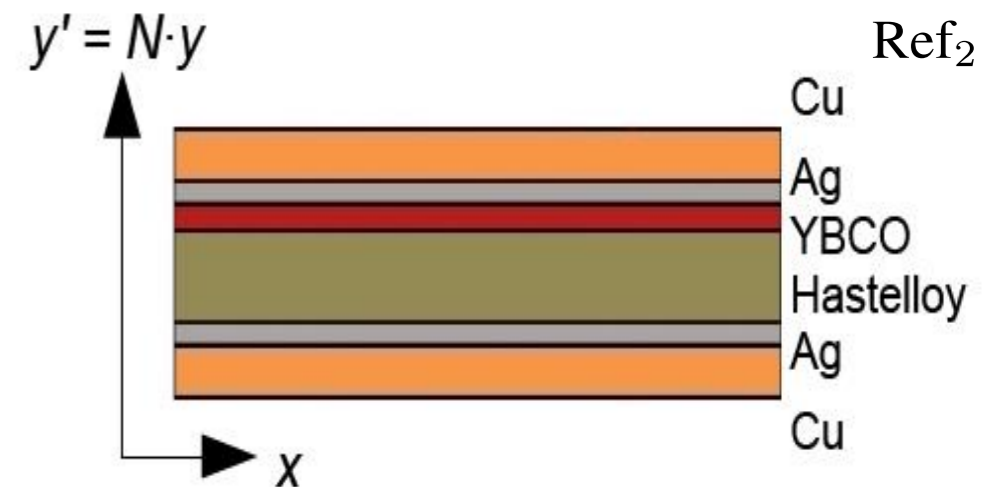
Ref₁

2D model with change of coordinates

- To cope with the high aspect ratio, the tape thickness is multiplied by a constant parameter N

Equation	Material Properties
$\rho c_p \frac{\partial T}{\partial t} = N \rho' c'_p \frac{\partial T}{\partial t}$	$c'_p(T) = c_p(T)$ $\rho' = \rho/N$
$-\frac{\partial k_x}{\partial T} \left(\frac{\partial T}{\partial x}\right)^2 = -N \frac{\partial k'_x}{\partial T} \left(\frac{\partial T}{\partial x}\right)^2$	$k'_x = k_x/N$
$-k_x \frac{\partial^2 T}{\partial x^2} = -N k'_x \frac{\partial^2 T}{\partial x^2}$	
$-\frac{\partial k_y}{\partial T} \left(\frac{\partial T}{\partial y}\right)^2 = -\frac{\partial k'_y}{N \partial T} \left(\frac{\partial T}{\partial y}\right)^2$	$k'_y = k_y \cdot N$
$-k_y \frac{\partial^2 T}{\partial y^2} = -k'_y \frac{\partial^2 T}{N \partial y^2}$	
$\sigma_x \left(\frac{\partial V}{\partial x}\right)^2 = N \sigma'_x \left(\frac{\partial V}{\partial x}\right)^2$	$\sigma'_x = \sigma_x/N$
$\sigma_y \left(\frac{\partial V}{\partial y}\right)^2 = \sigma'_y \left(\frac{\partial V}{\partial y}\right)^2 \frac{1}{N}$	$\sigma'_y = \sigma_y \cdot N$

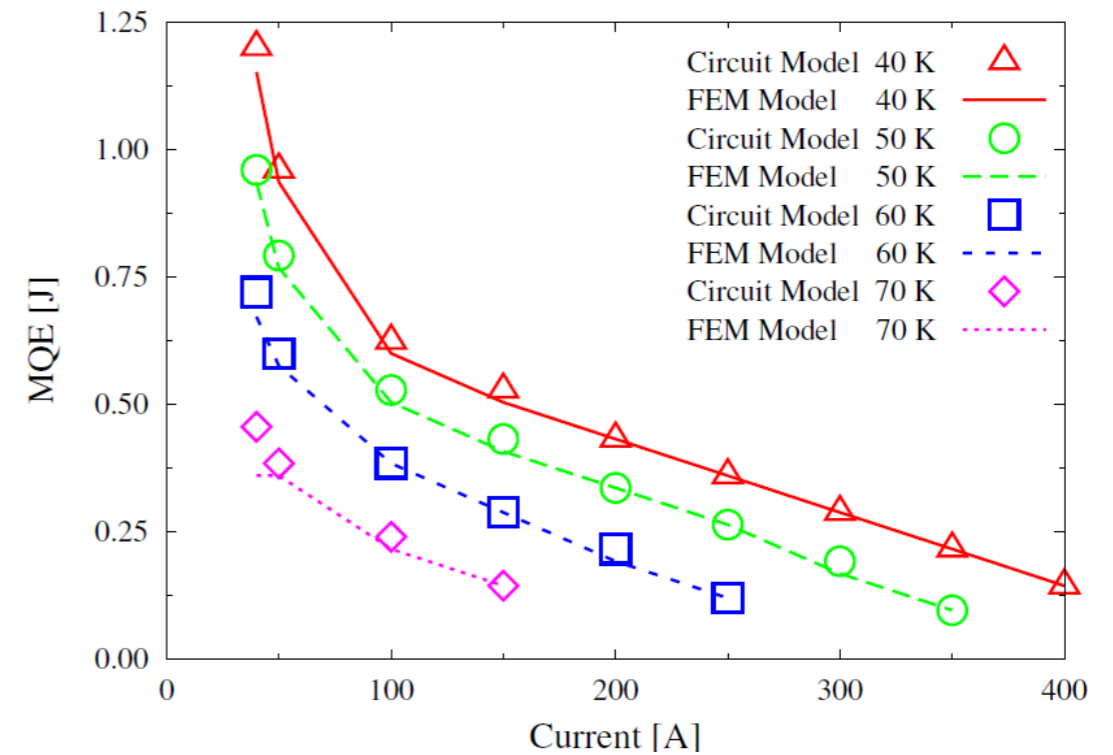
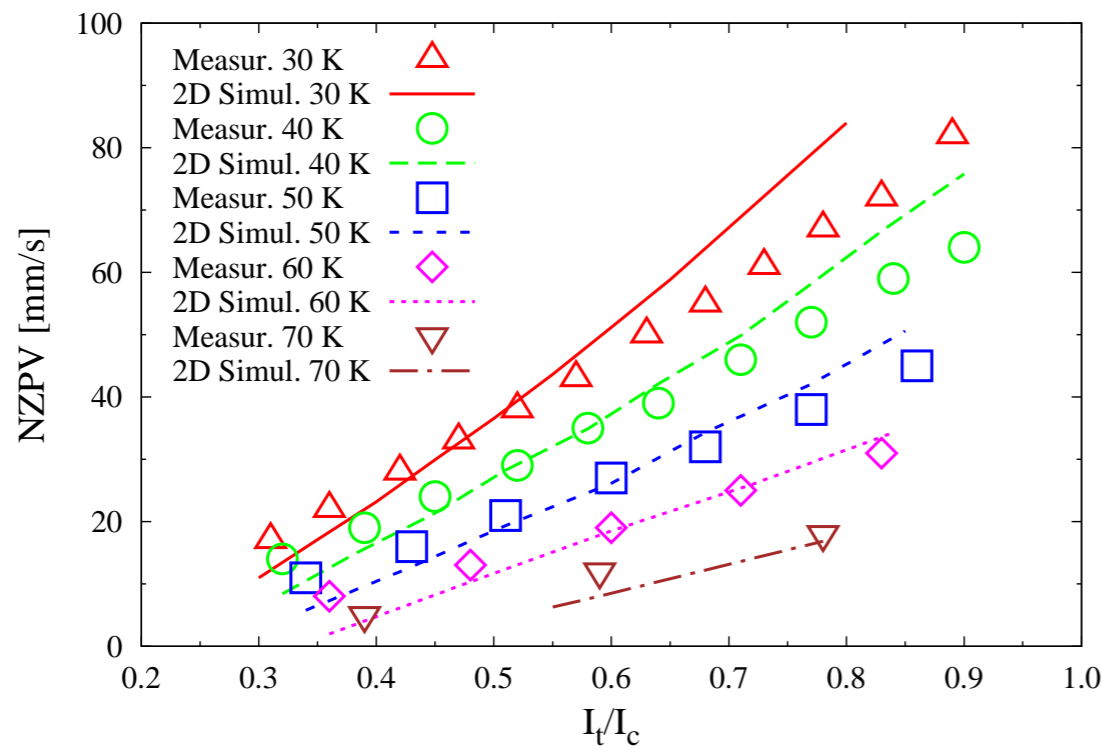
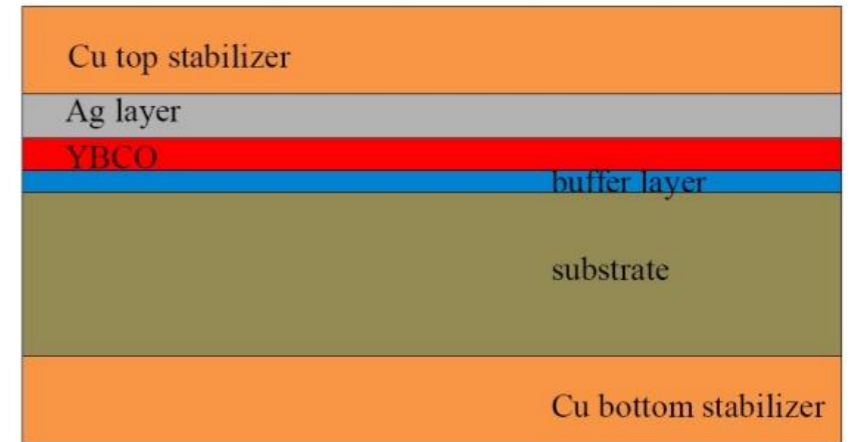
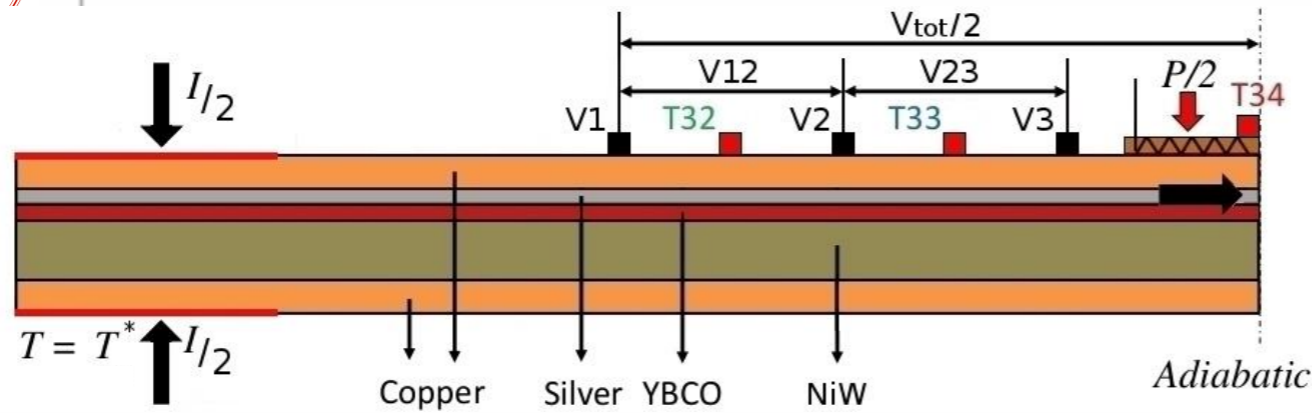
[7] M. Casali, M. Breschi, P. L. Ribani, *IEEE Trans. Appl. Supercondu.*, vol. 25, n. 1, 6862876, 2015



N	Free Triangular	
	Mesh elements	Computation time [s]
1	420000	-
50	20000	5423
100	10000	2792



HTS tape modeling: field vs circuit model



■ Significant reduction of computation time with **circuit model** relative to **field model**

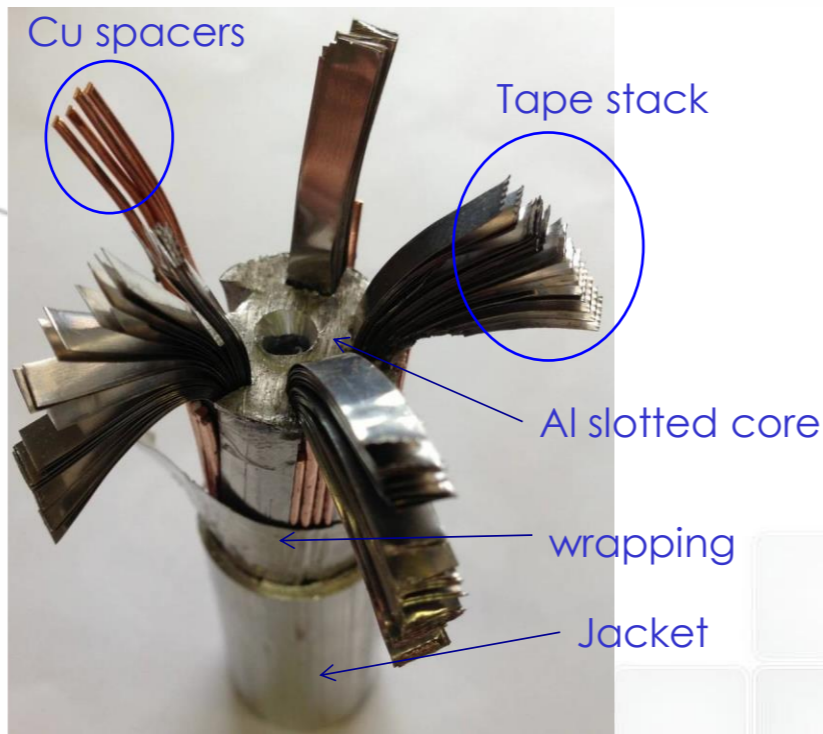
Computation time [s]	RECOVERY	QUENCH
Circuit	188	89
FEM	6329	1371



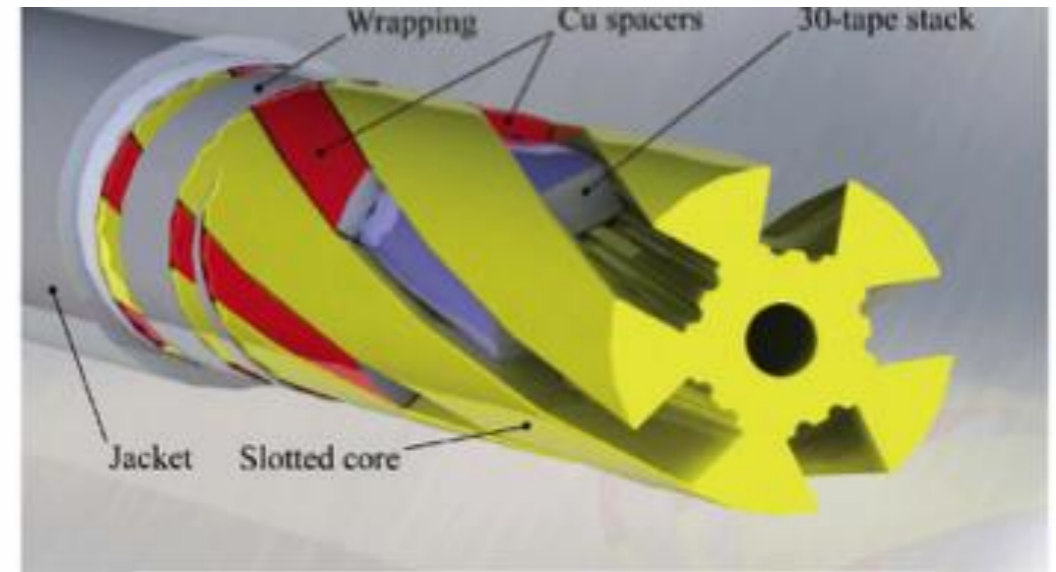
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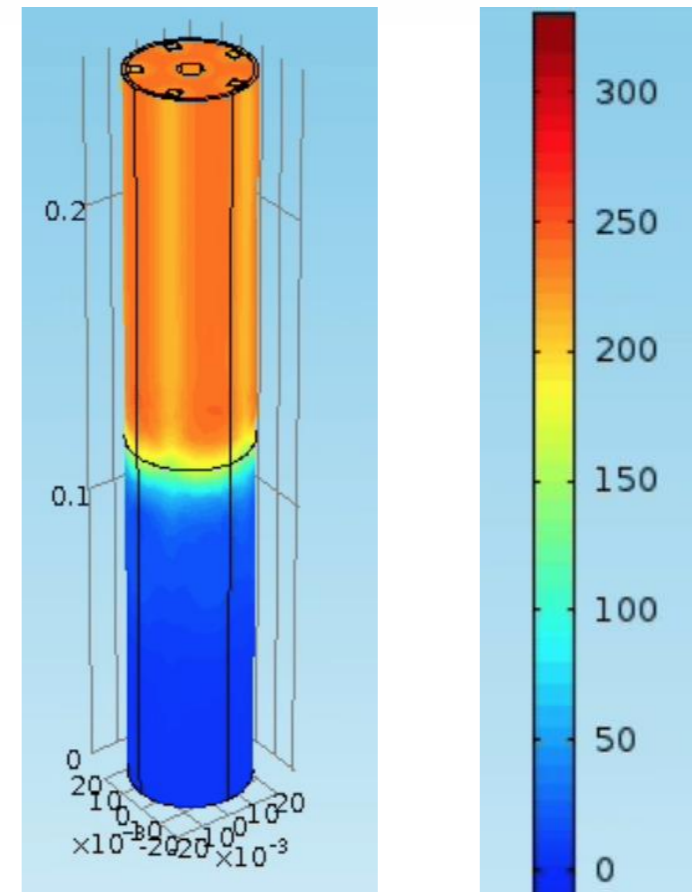
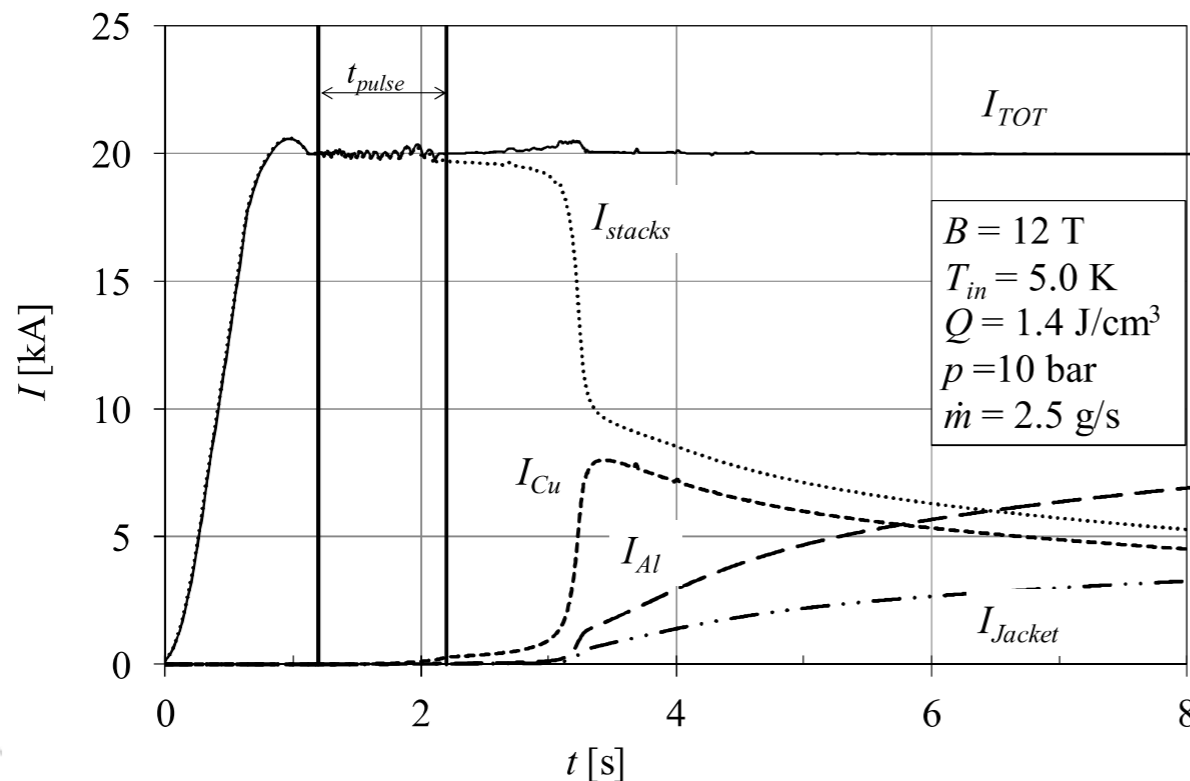
From tapes to cables: twisted stacked tape cable (slotted core)



Twisted stacked cable (ENEA Frascati)



Electro-thermal field model based on homogenization technique

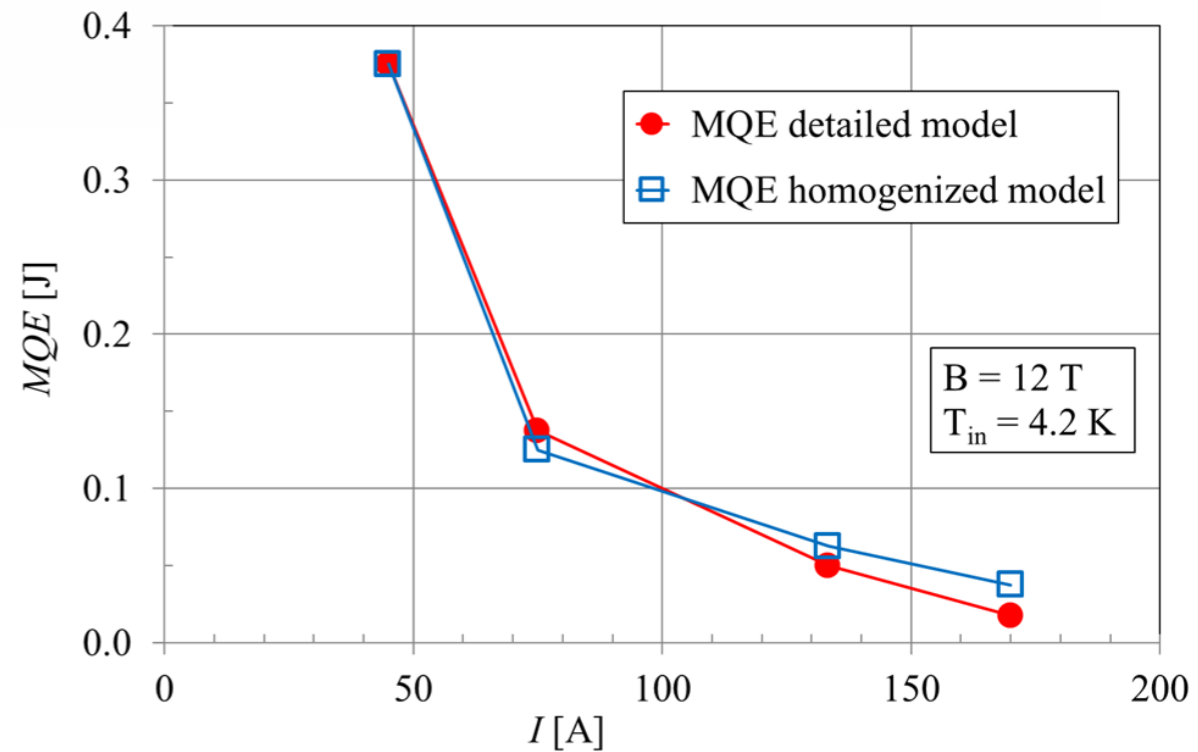
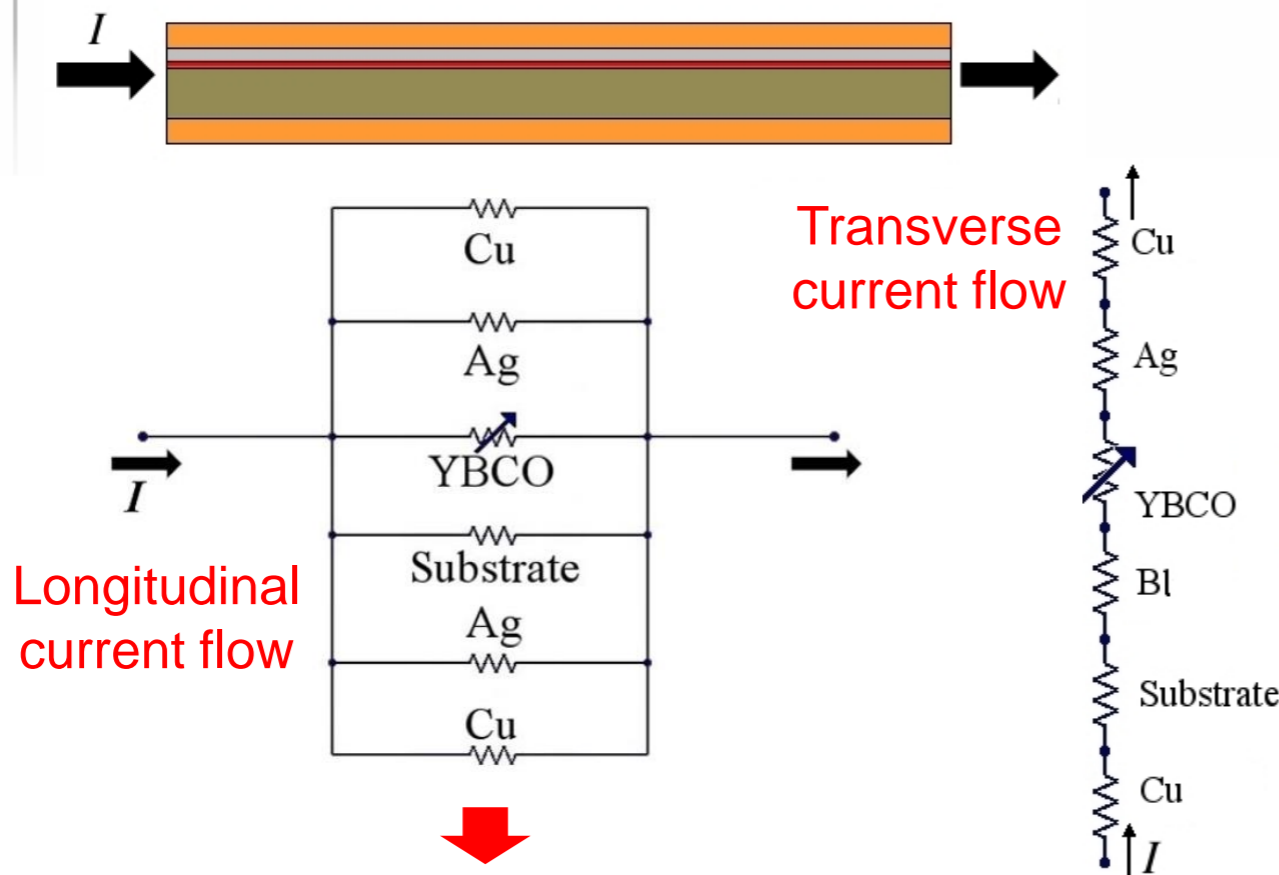


[8] M. Breschi, et al., *IEEE Trans. Appl. Supercondu.*, vol. 25, n. 3, 4800505, 2015



From tapes to cables: homogenization

- Increasing the number of degrees of freedom, modeling stacks requires **homogenization** techniques
- Resistances are taken in parallel for the longitudinal flow, and in series for the transverse flow, obtaining **anisotropic** properties



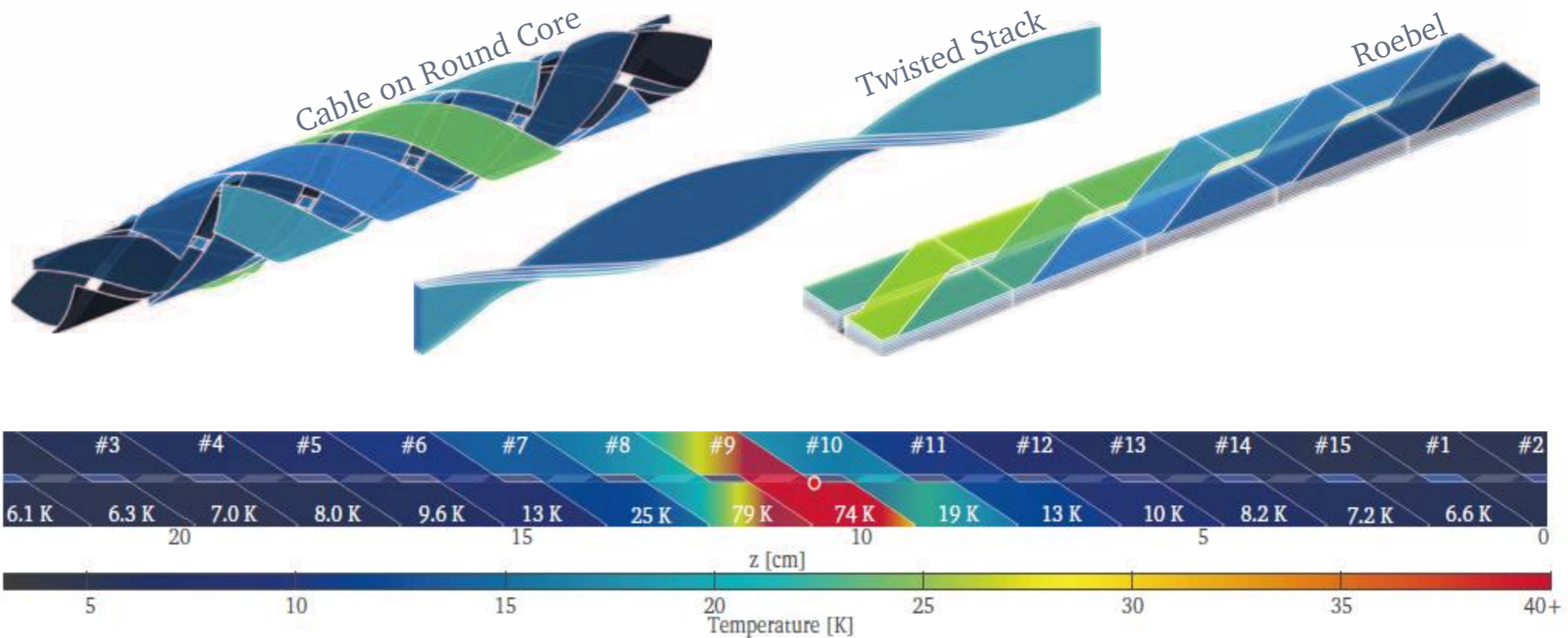
- The error on MQE due to homogenization **can reach 30 %**

$$\sigma_l = \frac{I_c(T, B)}{E_c S_{tot}} \left(\frac{E}{E_c} \right)^{\frac{1-n}{n}} + \sum_{j=1}^{N_l} \sigma_j(T, B) \frac{S_j}{S_{tot}}$$



From tapes to cables: 3D - thin strip

- Electromagnetic and thermal **network model** for quench analysis, AC loss and field quality



- Computation of current and temperature distribution during quench.

[9] J. Van Nugteren., «High Temperature Superconductors Accelerator Magnets», Ph.D. dissertation, University of Twente, 2016

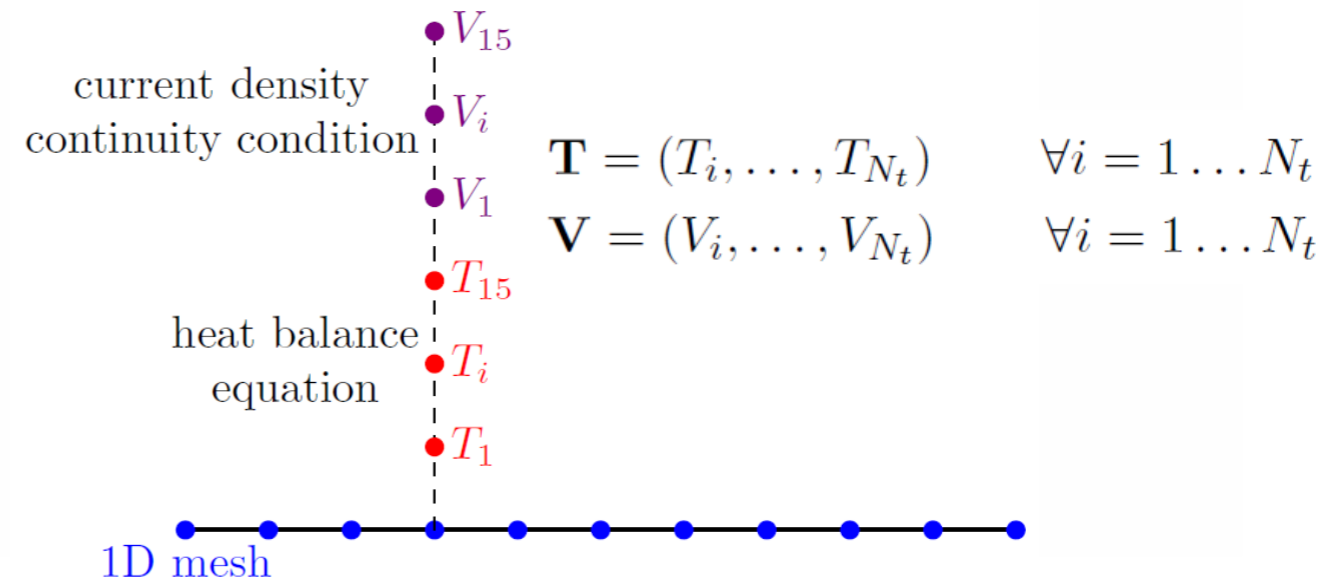
From tapes to cables: Roebel cable reduced dimensionality approach



Electrothermal model for quench calculation

■ The Roebel cable is described by means of a 1D FEM model.

■ At each mesh point, the model unknowns are the temperatures T_i and voltages V_i of each tape



■ The **heat diffusion equation** can be written for the i -th tape as

$$\rho C_p(T_i(x, t)) \frac{\partial T_i(x, t)}{\partial t} - \frac{\partial}{\partial x} \left(k(T_i(x, t)) \frac{\partial T_i(x, t)}{\partial x} \right) =$$

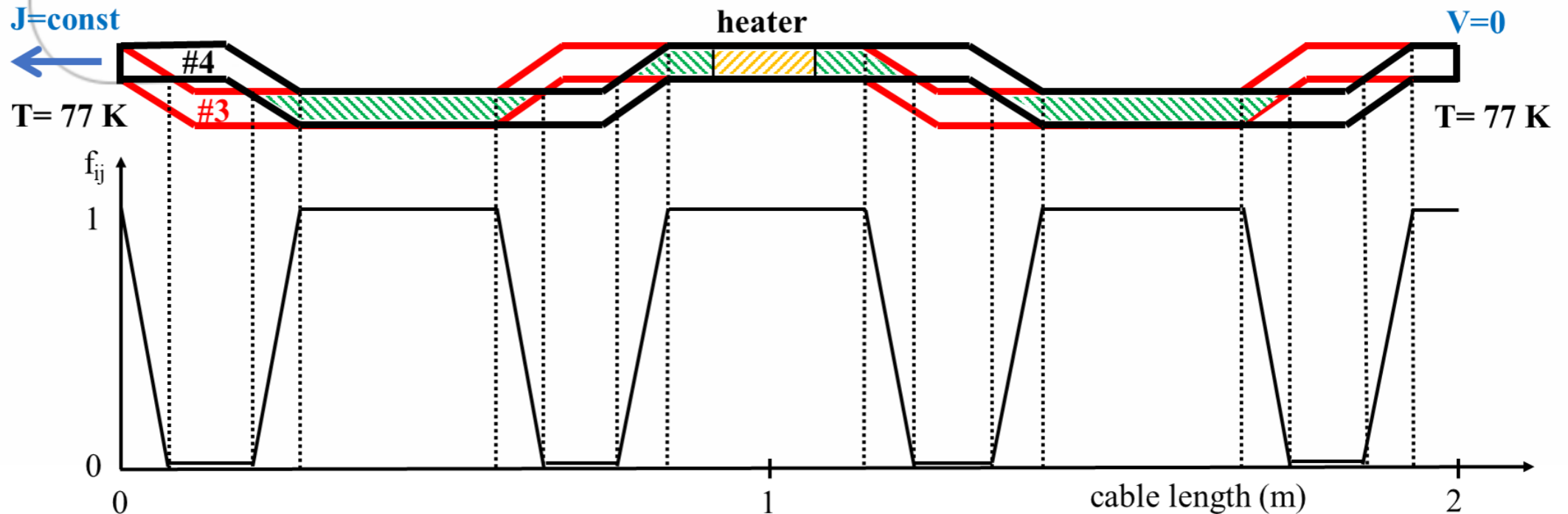
$$= \sigma_i(T_i(x, t), E_i(x, t)) \left(\frac{\partial V_i(x, t)}{\partial x} \right)^2 + \underbrace{\sum_j Q_{i,j}^J(x, t)}_{\text{thermal conduction between the } i\text{-th and } j\text{-th tapes in contact}} + \underbrace{\sum_j Q_{i,j}^c(x, t)}_{\text{Joule power due to the current exchange between the } i\text{-th and } j\text{-th tapes in contact}} + \underbrace{Q_i^h(x, t)}_{\text{heater thermal disturbance}}$$

[10] L. Cavallucci, M. Breschi, P. L. Ribani and Y. Yang, *IEEE Trans. Appl. Supercond.*, vol. 28, no. 4, Jun. 2018.

Joule power due to the current exchange between the i -th and j -th tapes in contact

heater thermal disturbance

From tapes to cables: Roebel cable reduced dimensionality approach



- The contact between different tapes is described through **non-uniform conductances**

- The electric potential at the reference terminal of the cable is set to 0

$$V_i = 0 \quad \forall i = 1 \dots N_t$$

- The current distribution is set on each tape at the other terminal

$$I_i(t) = k_i(t) \quad \forall i = 1 \dots N_t$$

$$\sum_{i=1}^{N_t} I_i(t) = I_{op}(t)$$

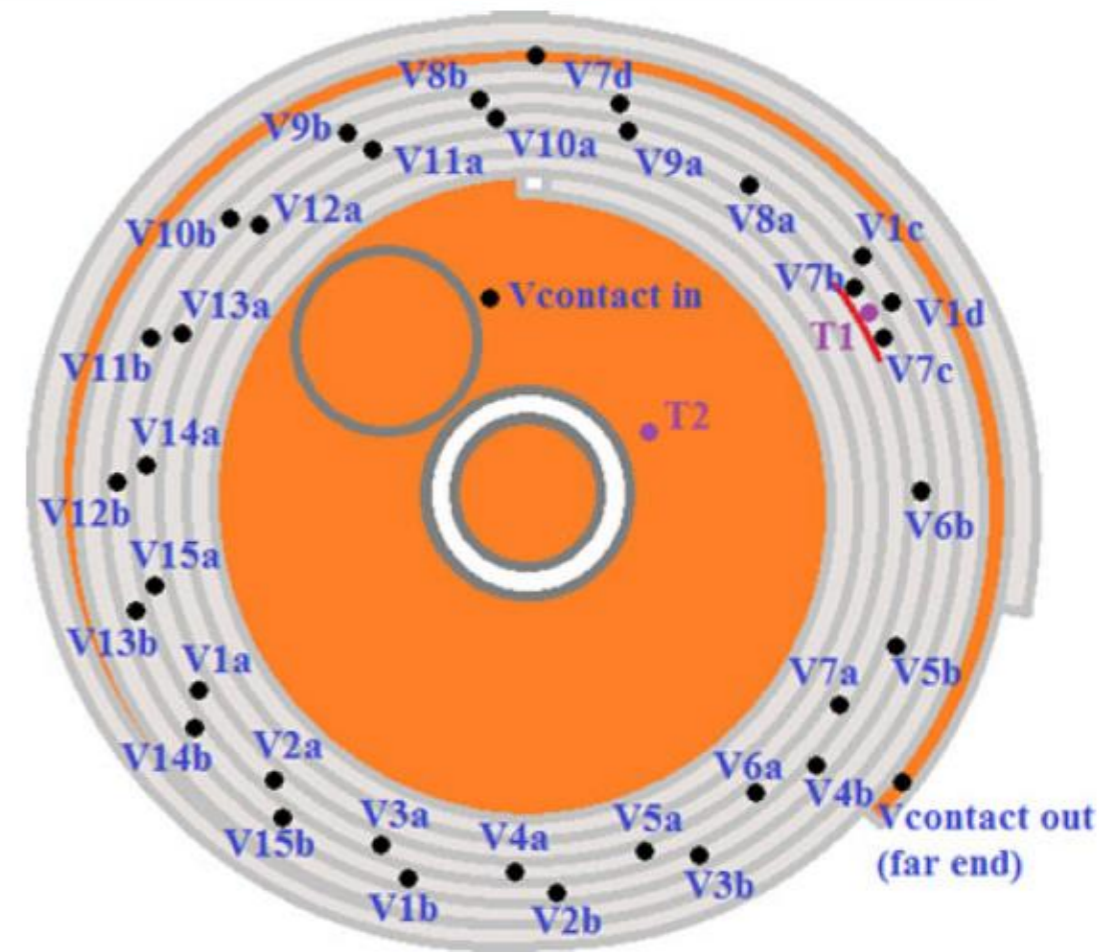
- Coupling with the **thermal model**

From tapes to cables: Roebel cable reduced dimensionality approach



Experiment at the University of Southampton

- A 2 m long Roebel cable with 15 strands YBCO tapes (Bruker EST) was wound into a **pancake coil of 7 turns** with 72 mm inner diameter.
- A length of **fiberglass ribbon** was co-wound as electrical insulation layer; the coil was then impregnated with epoxy resin.
- At the 4th turn of the coil, a **miniature heater** was attached to tape #7 at the inner face of the turn
- Quench experiments were performed at **77 K**, 450 A transport current



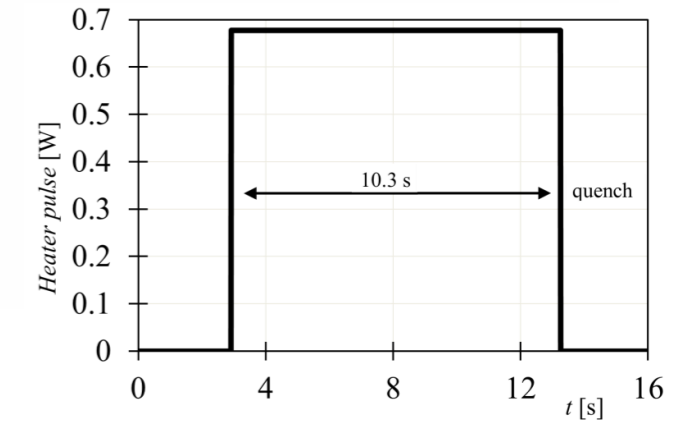
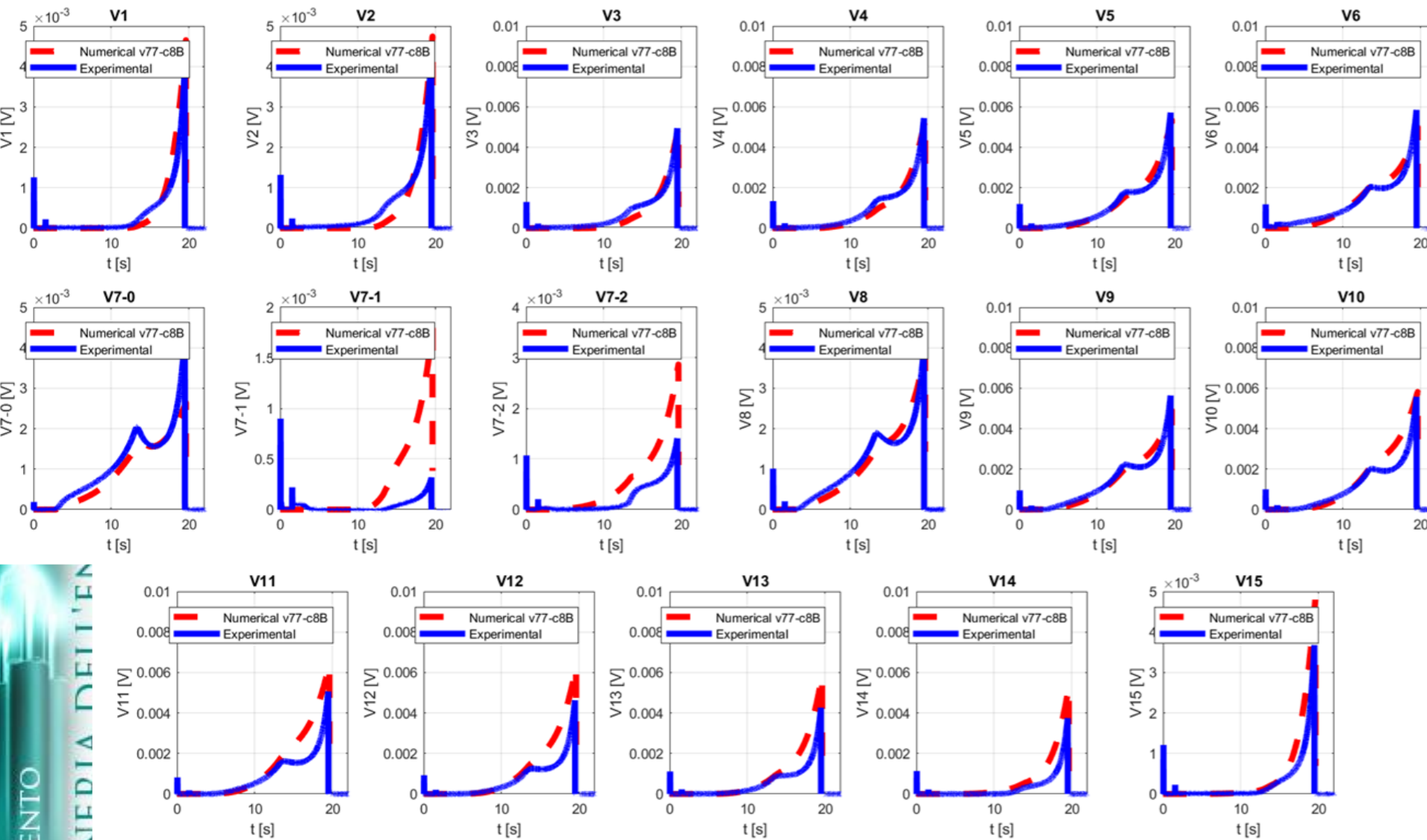
[11] Q. Zhang, et. al., *IEEE Trans. Appl. Supercond.*, vol. 28, no. 4, Jun. 2018.



From tapes to cables: Roebel cable reduced dimensionality approach

Model vs experiment

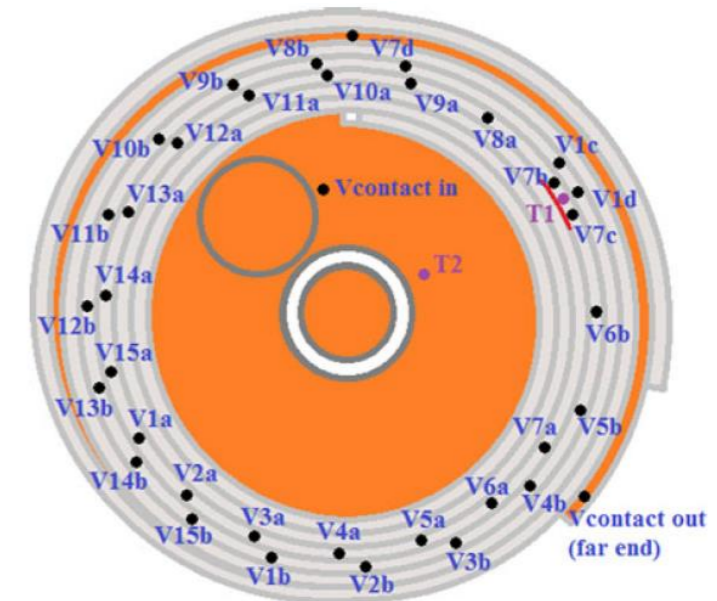
- A good agreement was found between the experimental and numerical results



$$V7_1 = V7a - V7b$$

$$V7_2 = V7c - V7d \quad Vn = Vna - Vnb$$

$$V7_0 = V7b - V7c$$

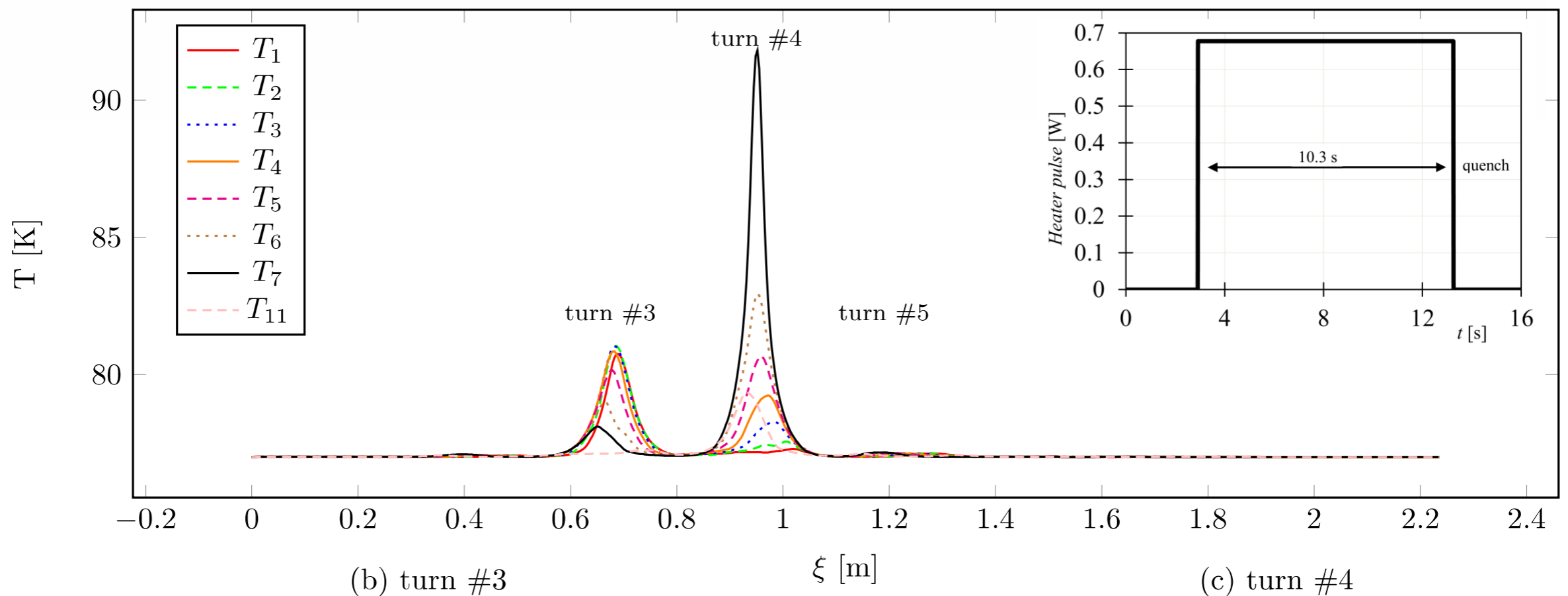




From tapes to cables: Roebel cable reduced dimensionality approach

Quench propagation in the longitudinal and radial direction

- The temperature distribution *at the end of the heater pulse* shows the effects of the heat transverse **between tapes** of the cable and from **turn to turn**



- For some tapes, the heat redistribution **between turns** is faster than within the same turn

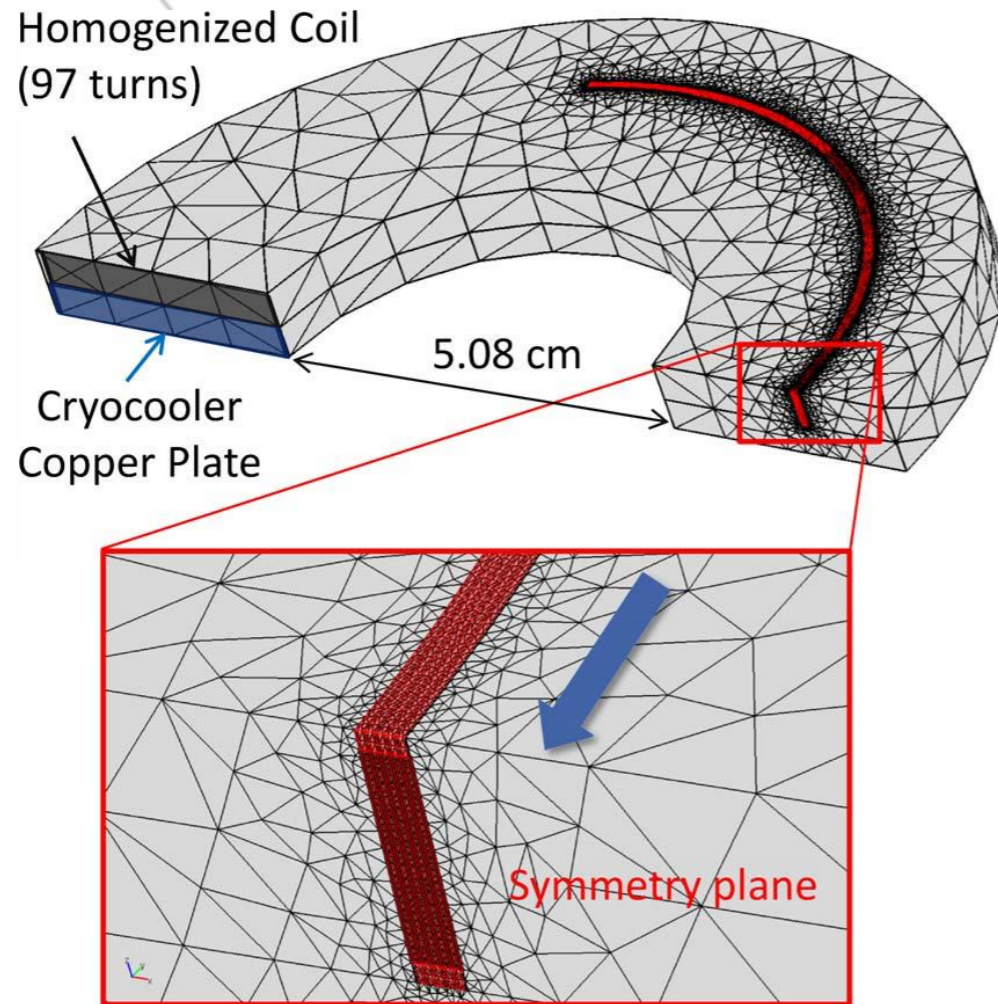


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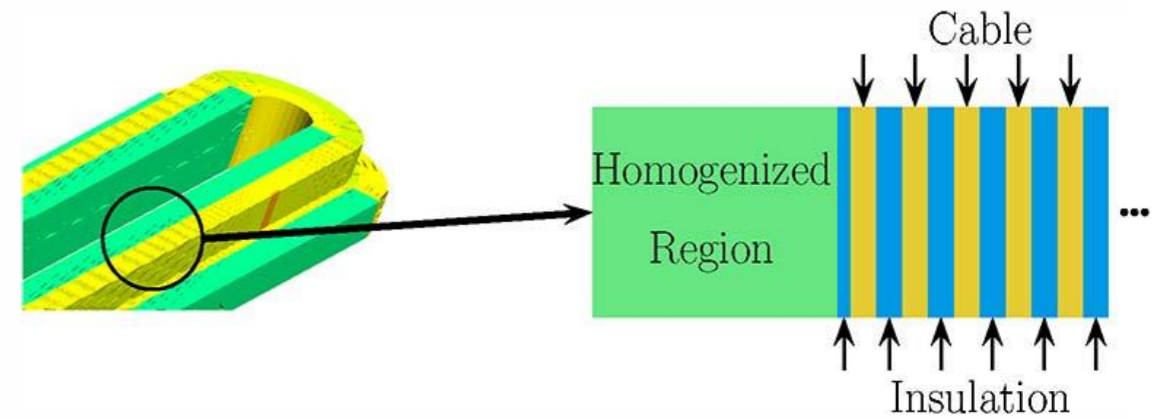


Scaling up: full coil models



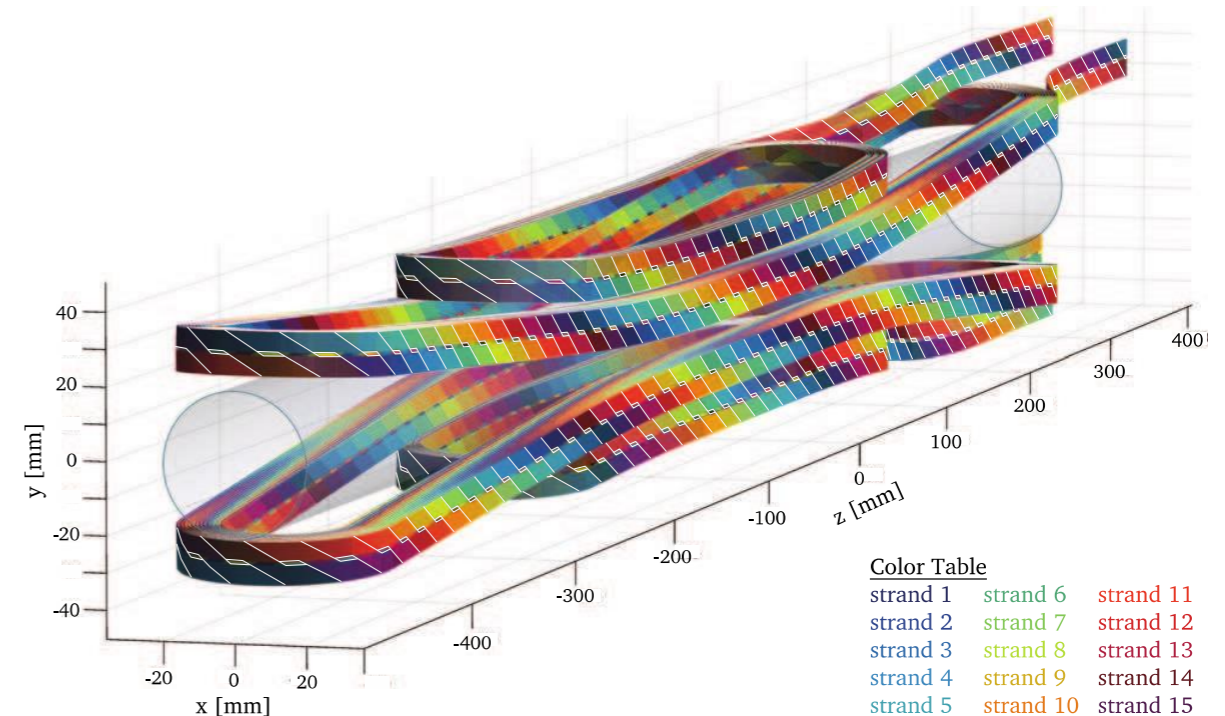
- Multiscale coil model composed of a homogenized coil and a localized embedded **multilayer tape module** (inset)

[12] W. K. Chan, J. Schwartz, *IEEE Trans. Appl. Supercond.*, vol. 22, no. 5, 4706010, 2012.



- Coil represented in some parts as a homogenous **mixture of cable and insulation**, in other parts as structure including cable and insulation layers

[13] E. Härö and A. Stenvall, *IEEE Trans. Appl. Supercond.*, vol. 24, no. 3, 4900705, 2014.



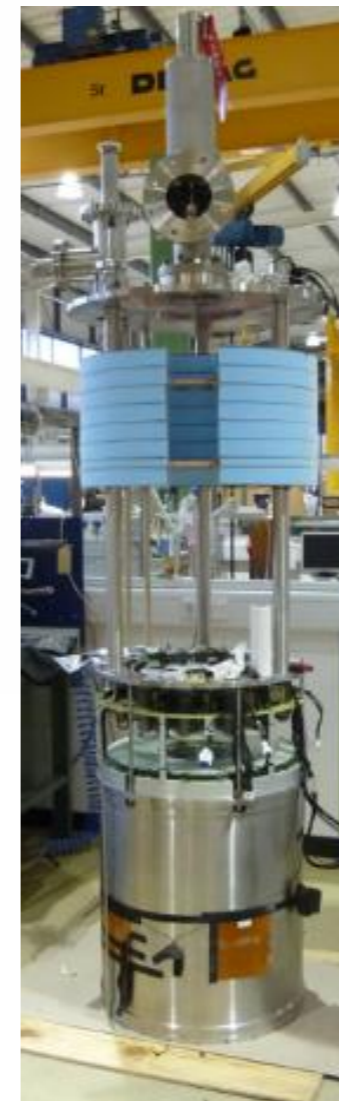
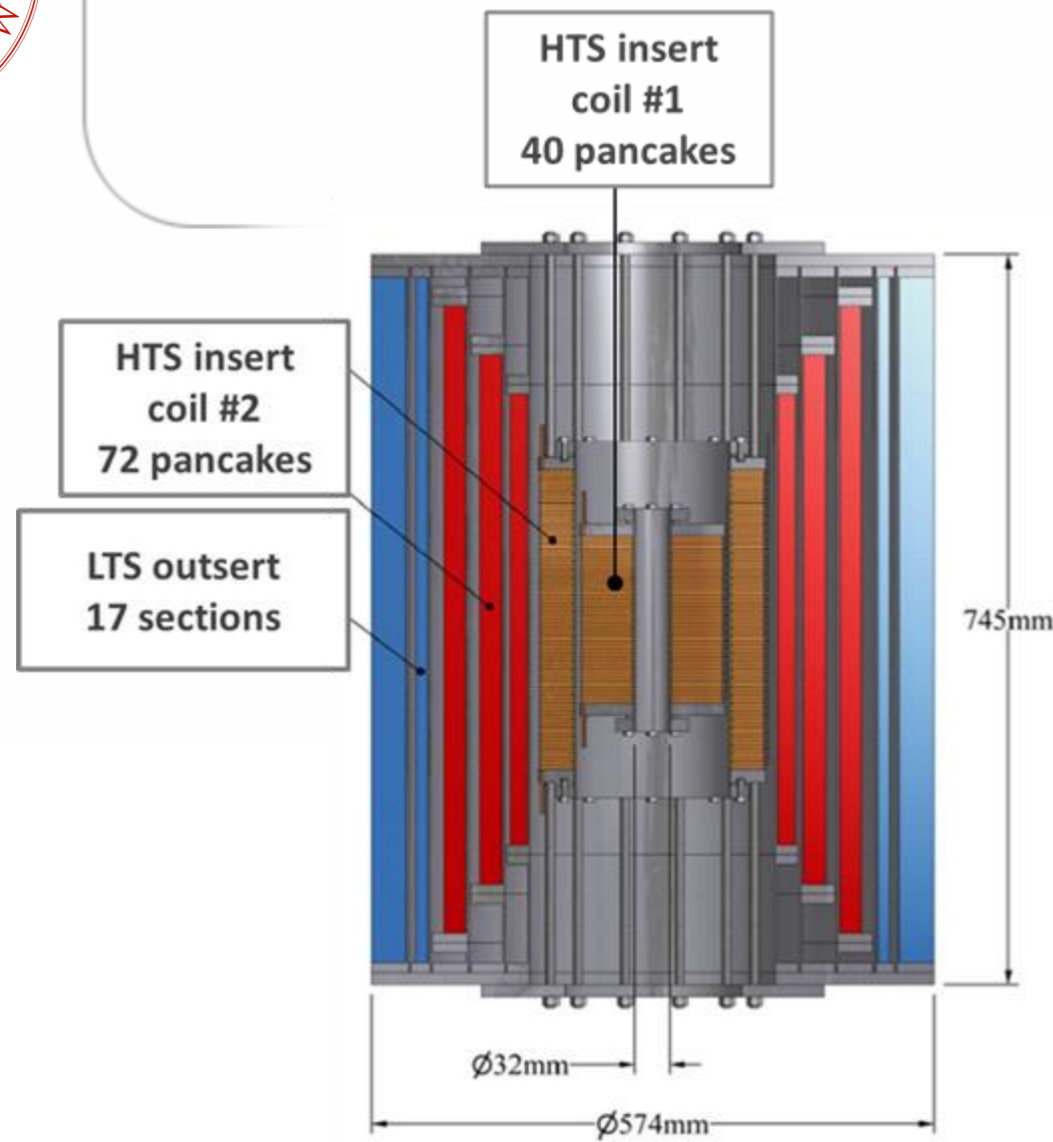
[9] J. Van Nugteren., Ph.D. dissertation, University of Twente, 2016



Scaling up: 32 T NHMFL magnet model

32 T MAGNET

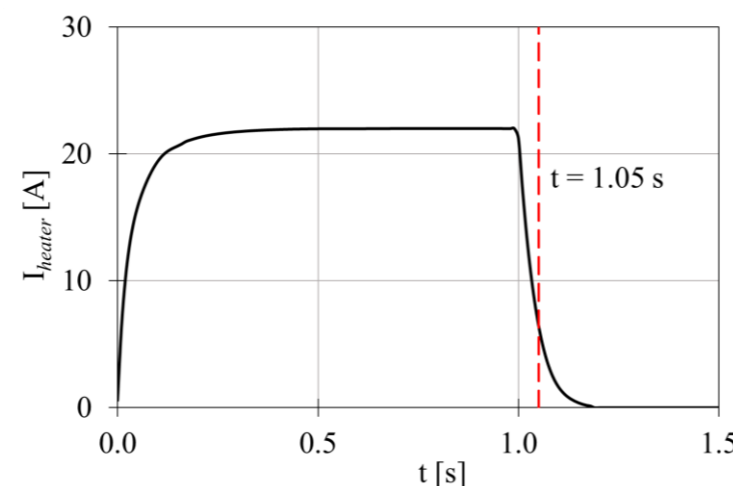
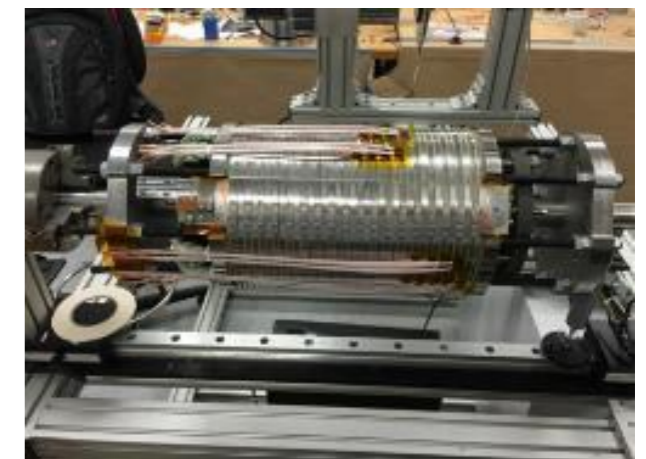
Parameter	Value
Central Field	32 T
LTS Outsert Field	15 T
HTS Insert Field	17 T
Central Bore	34 mm
Ramp time	1 h
Operating temperature	4.2 K
Stored Energy	8.3 MJ
System weight	2.6 ton



HTS insert coil #1 (10.7 T)



HTS insert coil #2 (6.3 T)



[14] H. W. Weijers et al., *IEEE Trans. Appl. Supercond.*, vol. 24, no. 3, Jun. 2014, Art. ID. 4301805.

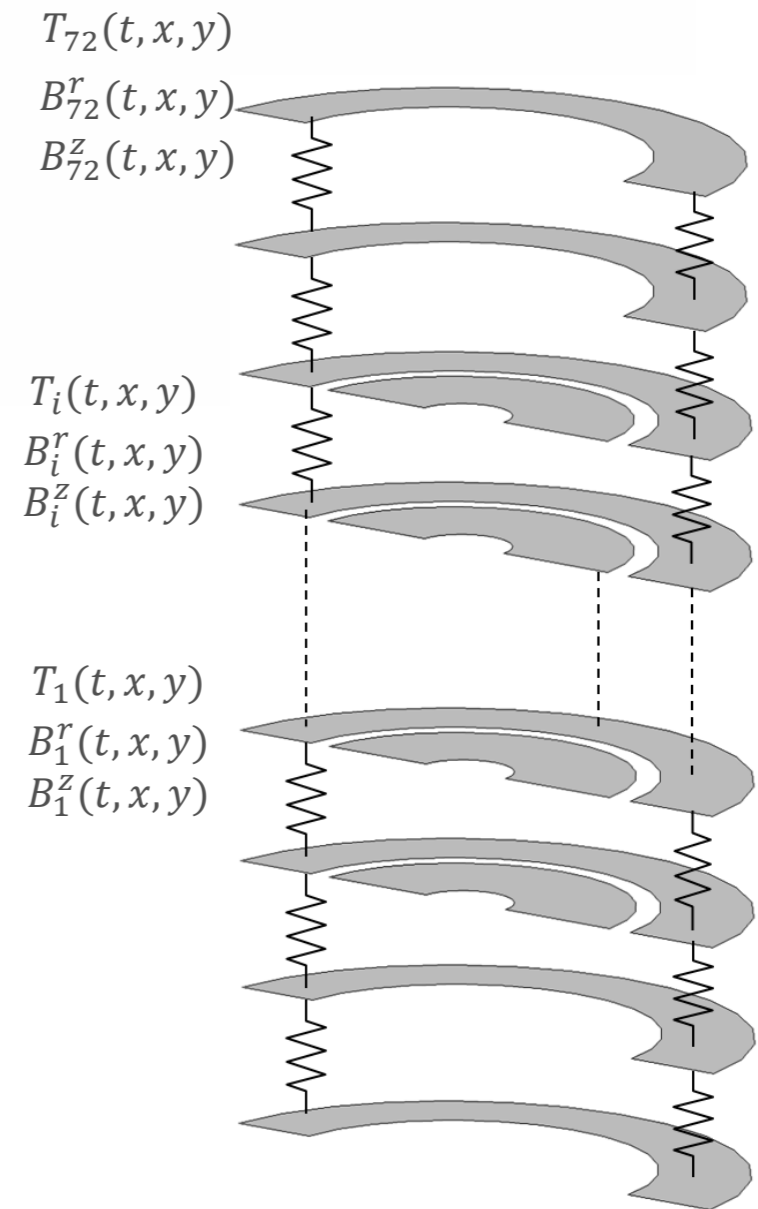
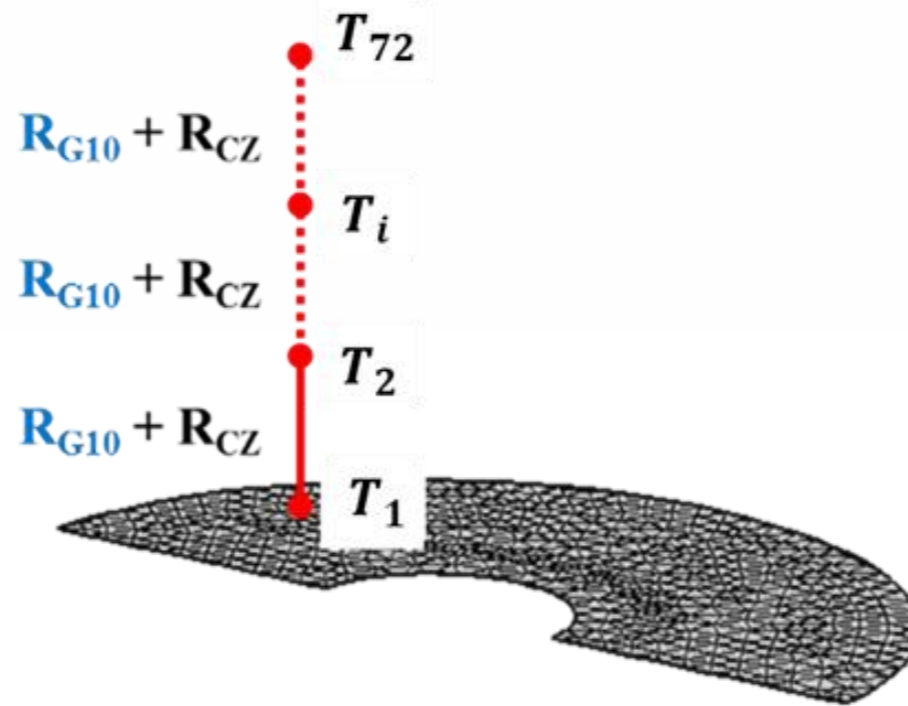


Scaling up: 32 T NHMFL magnet model

- Only one 2D pancake is discretized with a mesh. At each mesh point, a set of heat balance equations is written for an array of temperatures

$$T = [T_1(x, y) \quad \dots \quad T_i(x, y) \quad \dots \quad T_{72}(x, y)]$$

R_{G10}, R_{Cz}
DISTRIBUTED
THERMAL
RESISTANCES



Axial heat flux between

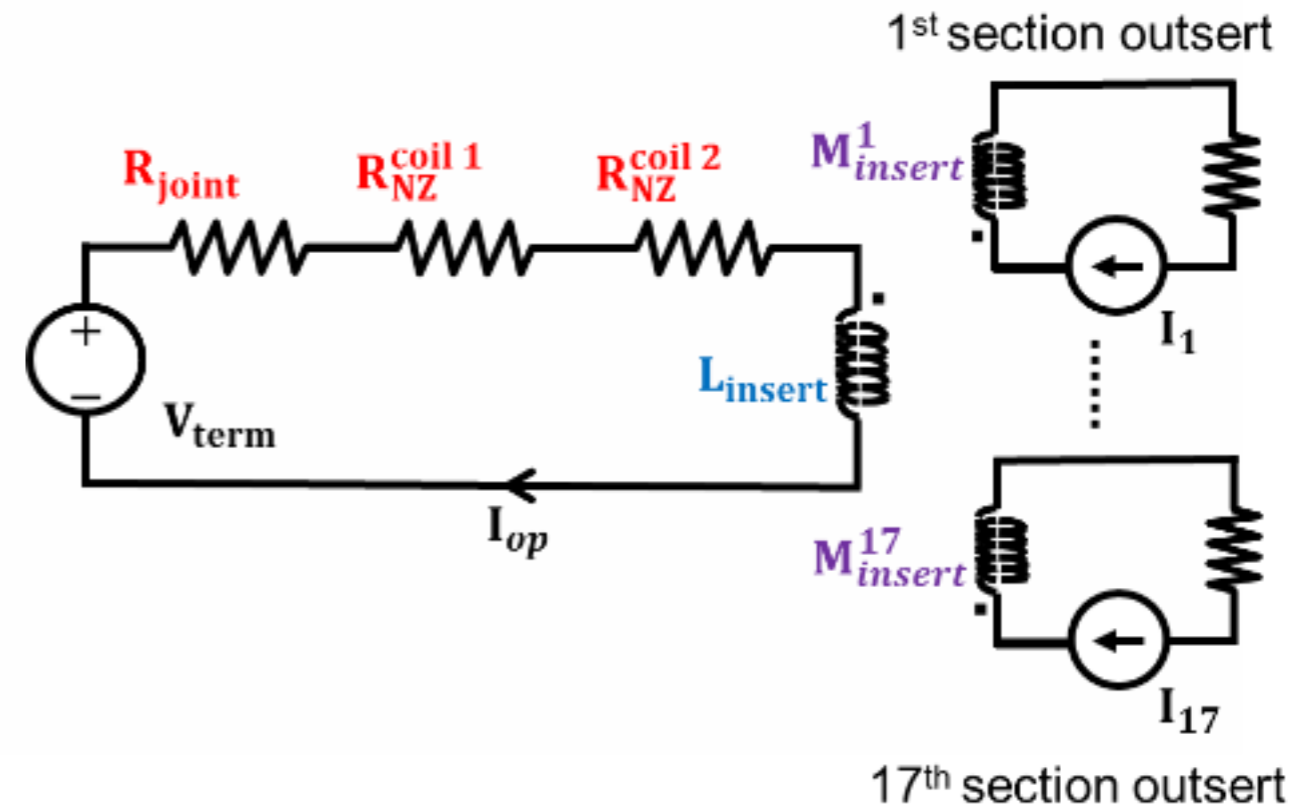
$$Q_{axial}^{cond} = \frac{T_{i+1} - T_i}{V_p (R_{G10}^{i,i+1} + R_{cz})} - \frac{T_i - T_{i-1}}{V_p (R_{G10}^{i,i+1} + R_{cz})}$$



Scaling up: 32 T NHMFL magnet model

Coil constitutive law

- Lumped parameter circuit describing the mutual induction coupling between the insert and the 17-sections outsert



$$V_{ground} = (R_{NZ}^{coil 1}(t) + R_{NZ}^{coil 2}(t) + R_{joint})I_{op} + L_{insert} \frac{dI_{op}}{dt} + \sum_{j=1}^{17} M_{insert}^j \frac{dI_j}{dt}$$

- The resistances of coil 1 and coil 2 can be computed from the power dissipated in all pancakes

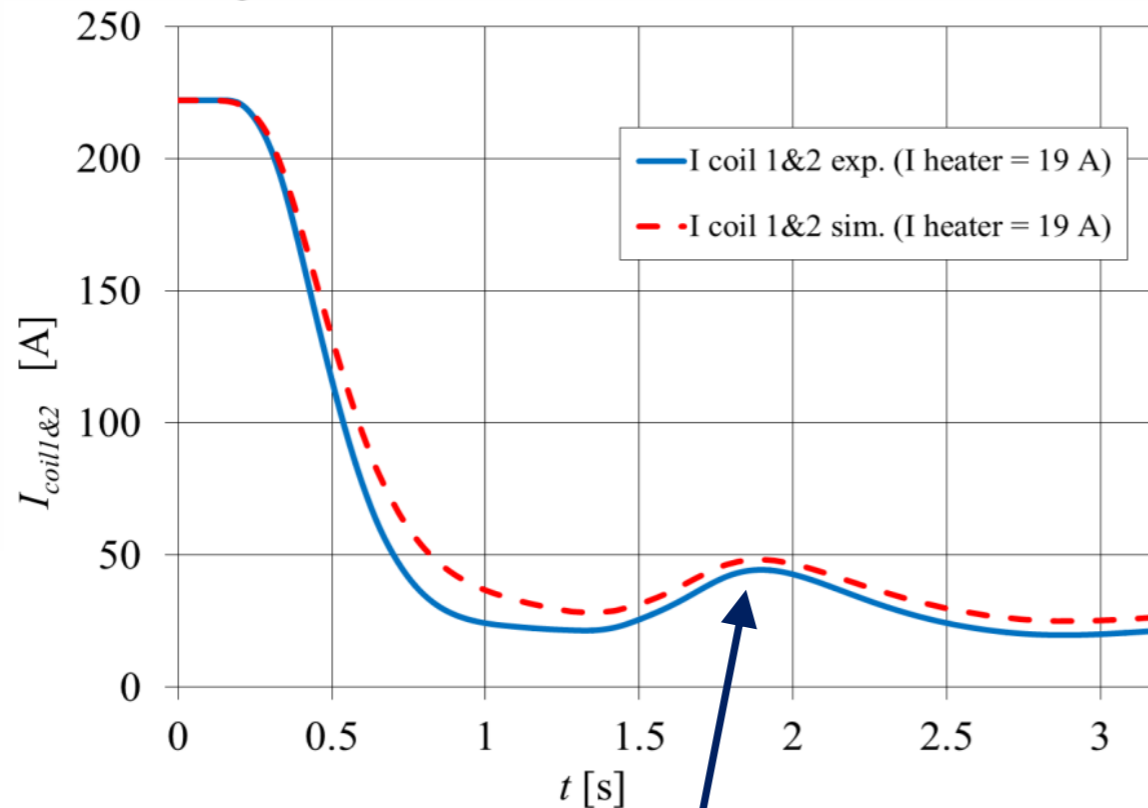
$$R_{NZ}^{coil 2}(t) = \frac{2}{I_{op}^2} \sum_{i=1}^{12} \int_{V_i} \frac{J^2(t)}{\sigma_i(t, x, y)} dV_i$$

$$R_{NZ}^{coil 1}(t) = \frac{2}{I_{op}^2} \left(\sum_{i=1}^{16} \int_{V_i} \frac{J^2(t)}{\sigma_i(t, x, y)} dV_i + \sum_{i=57}^{72} \int_{V_i} \frac{J^2(t)}{\sigma_i(t, x, y)} dV_i \right)$$

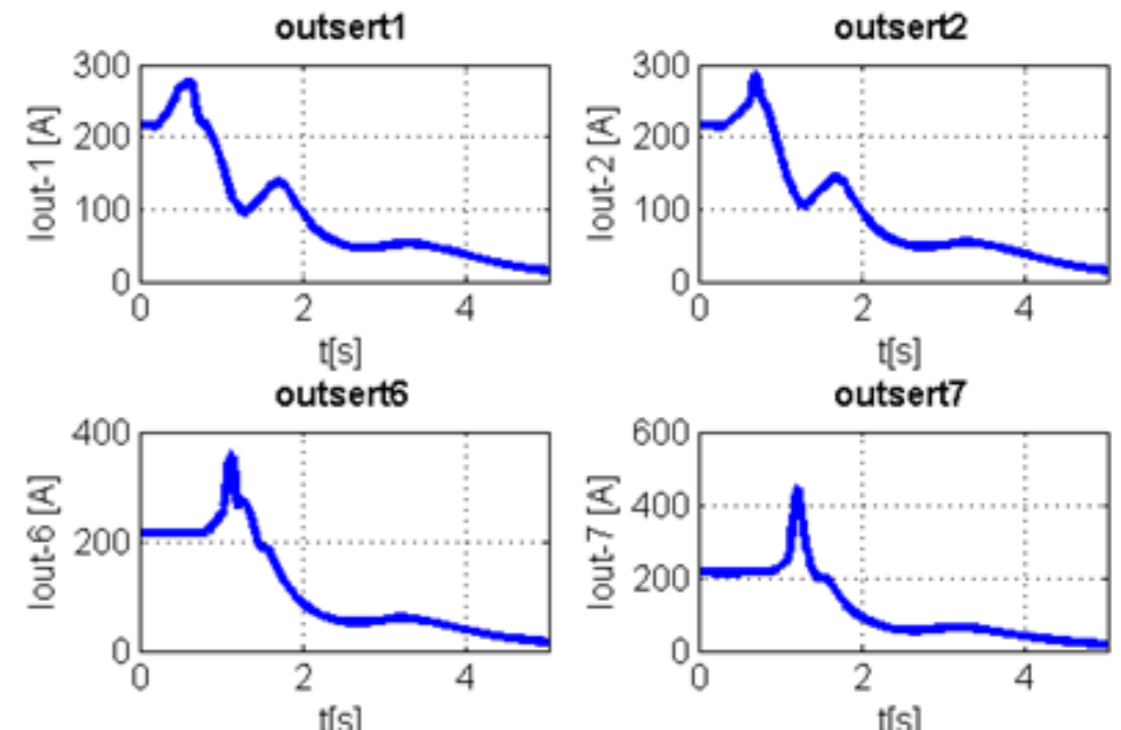
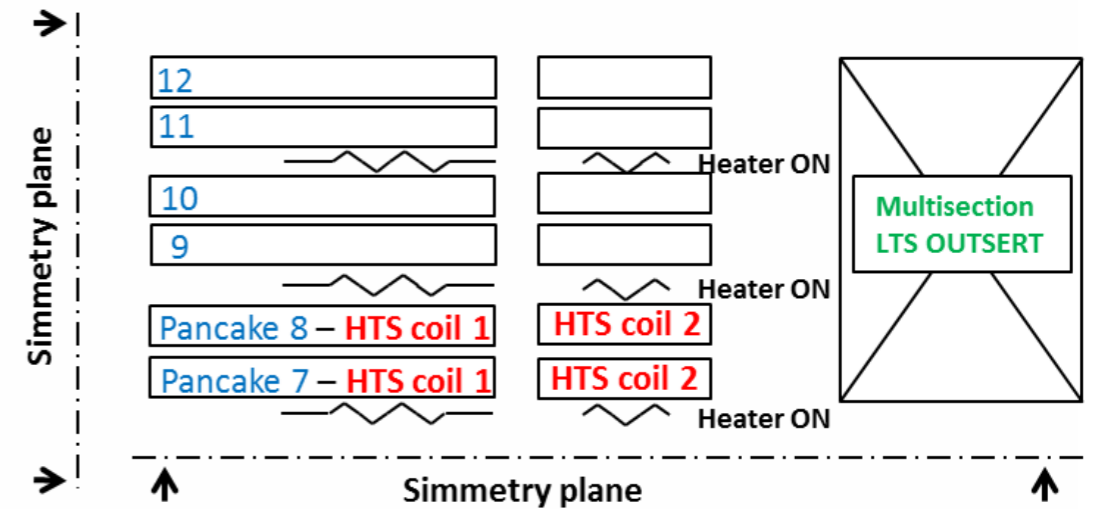


Scaling up: 32 T NHMFL magnet model

- The model was first validated versus the tests of prototype coils made of 12 pancakes



- A local peak of the insert transport current during the discharge is due to the **inductive coupling** between the insert and the outsert

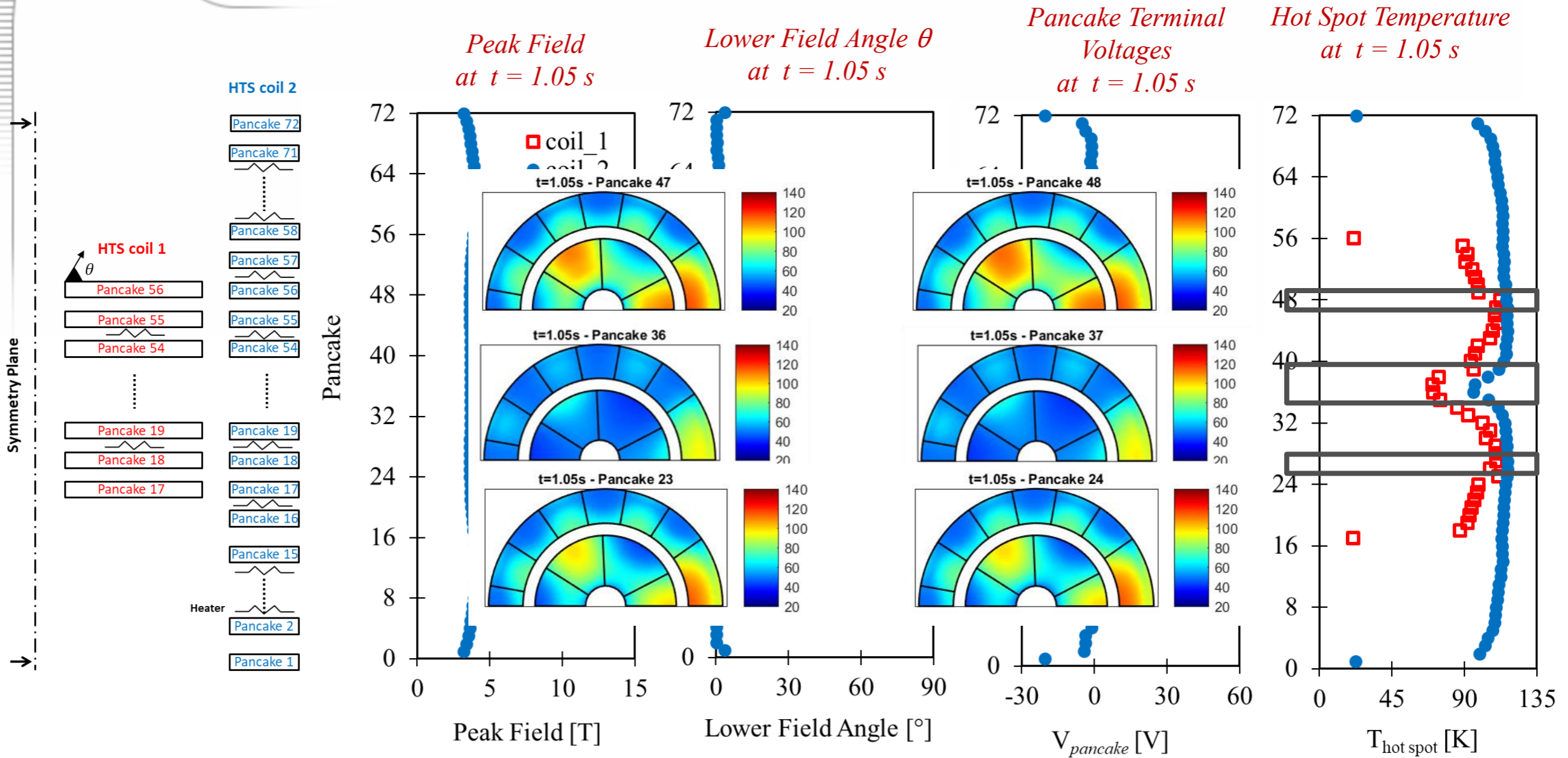


Outsert currents during quench



Scaling up: 32 T NHMFL magnet model

- The model was then applied to analyze the self field quench test of the 32 T magnet (no current in the outsert)



- The most dangerous hot spot locations derive from a trade-off between magnetic field and field angle impacting J_c



Outline

- Introduction
- HTS tape modeling
- From tapes to cables
 - Twisted Stacked Tape Cable
 - Roebel cables
- Scaling up: coils and magnet systems
- **Discussion**



Discussion: simulations

- Impressive advances have been made in the last 15 years in the modeling of HTS devices, from single tape to full coils
- The crucial techniques adopted are *homogenization*, *reduced dimensionality* and *multi-scale approach*
- To improve the models as *predictive* tools, we could benefit from:
 - Shared material properties and parameterizations of the critical surface for wide ranges of temperature, field
 - Interface properties (electrical and thermal contact resistances)
 - Improvement of computation speed (parallel computing)
 - Predictive analysis and comparison between models and dedicated experiments



Discussion: design

- Concerning *quench and current distribution*, much more **analytical work** was performed for LTS than for HTS (different times of the theory development ?)
- Results available for the LTS can be extended to HTS, but not always (NI coils, Roebel cables, etc)
- Analytical formulae for the calculation of current distribution **time constants and lengths, quench energy, propagation velocity**, would be useful for the design *of* HTS based magnets

Thank you for your attention



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